

Version: G

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Approval Sheet

(產品承認書)

產品名稱	(Product)	Bluetooth Low Energy Module		
解決方案	(Solution)	Nordic nRF52811 QFN Package		
產品型號	(Model No.)	MDBT42Q – 192KL (Chip Antenna)		
		MDBT42Q - P192KL (PCB Antenna)		
產品糾號	(Part No.)	see 4.3 Order code		

Advantage of MDBT42Q & MDBT42Q-P series:

1. Long working distance:

MDBT42Q: over 80 meters in open space.

MDBT42Q-P: up to 60 meters in open space.

- 2. Declaration ID includes all Nordic applied profiles.
- 3. Granted main regional certification such as FCC (USA), CE(EU)

 TELEC (Japan), SRRC (China), IC (Canada), NCC (Taiwan), and KC (South Korea).

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1. Overall introduction

Raytac's MDBT42Q-192KL & MDBT42Q-P192KL is a BT 5.2 stack (Bluetooth low energy or BLE) module designed based on **Nordic nRF52811 SoC solution**, which incorporates: **GPIO**, **SPI**, **UART**, **I2C**, **PWM** and **ADC** interfaces for connecting peripherals and sensors.

Features:

- 1. Dual Transmission mode of BLE & 2.4GHz RF upon customer preference.
- 2. Compact size with (L) 16 x (W) 10 x (H) 2.2 mm.
- 3. Low power requirements, ultra-low peak, average and idle mode power consumption.
- 4. Be compatible with a large installed base of mobile phones, tablets and computers.
- 5. Fully coverage of BLE software stack.
- 6. BLE & RF transmission switching helps products fit all operation system and most hardware.

1.1. Application

- · Personal Area Networks
 - · Health / fitness sensor and monitor device
 - · Medical devices
 - Key-fobs and wrist watches
- Interactive entertainment devices
 - Remote control
 - Gaming controller
 - · Virtual reality headsets
- Enterprise Lighting
- Beacons
- Computer peripherals and I/O devices
 - Mouse
 - Keyboard
 - Multi-touch trackpad

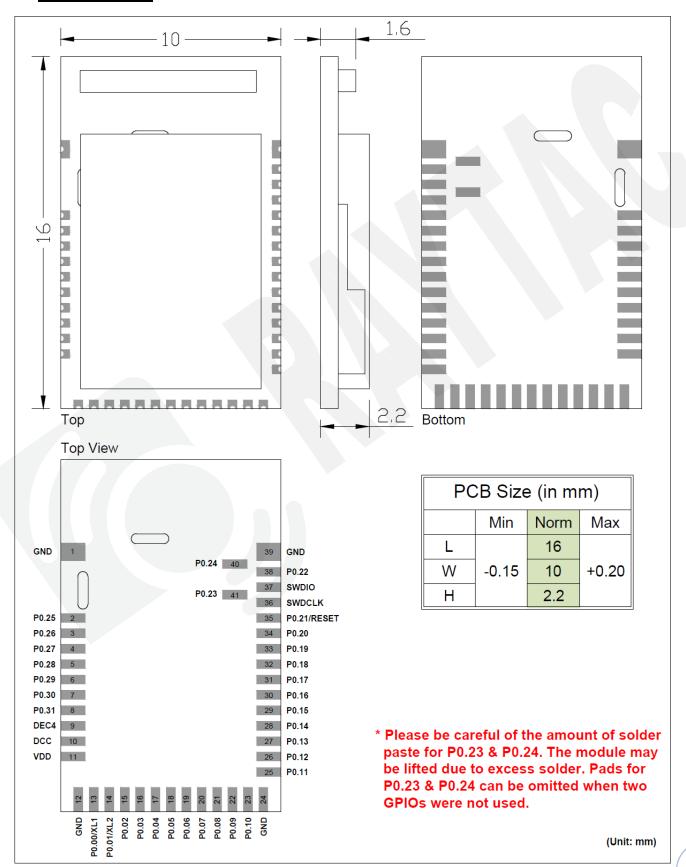
1.2. Features

- Bluetooth 5, IEEE 802.15.4, 2.4 GHz transceiver
 - -97dBm sensitivity in 1 Mbps Bluetooth low energy (BLE) mode
 - -104dBm sensitivity in 125 Kbps BLE mode (long range)
 - -20 to +4 dBm TX power, configurable in 4 dB steps
 - On-air compatible with nRF52, nRF51, nRF24L and nRF24AP Series
 - RSSI (1dB resolution)
 - · Supported data rates:
 - Bluetooth 5: 2 Mbps, 1 Mbps, 500 kbps, 125 kbps
 - IEEE 802.15.4-2006: 250 kbps
 - · Proprietary 2.4 GHz: 2 Mbps, 1 Mbps
- · Angle-of-arrival (AoA) and angle-of-departure (AoD) direction finding using Bluetooth.
- ARM Cortex –M4 32-bit processor with FPU, 64 MHz
- · Memory: 192 kB flash / 24 kB RAM
- 32 general purpose I/O pins
- 12 bit, 200ksps ADC 8 configurable channels with programmable gain
- 4-channel pulse width modulator (PWM) units with EasyDMA
- Digital microphone interface (PDM)
- 2 x SPI master/slave with EasyDMA
- I2C compatible 2-wire masters / slaves
- 1 x UART(CTS/RTS) with EasyDMA
- Quadrature decoder (QDEC)
- 2 x real-time counters (RTC)
- Flexible power management
 - Supply voltage range 1.7V to 3.6V
 - Fully automatic LDO and DC/DC regulator system
 - Fast wake-up using 64MHz internal oscillator
 - 0.3 uA at 3V in System OFF mode, no RAM retention
 - 0.5 uA at 3V in System OFF mode with full 24 kb RAM retention
 - 1.5 uA at 3V in System ON mode, with full 24 kb RAM retention, wake on RTC
 - 1.4 uA at 3V in System ON mode, no RAM retention, wake on RTC
- Nordic SoftDevice ready and with support for concurrent multi-protocol

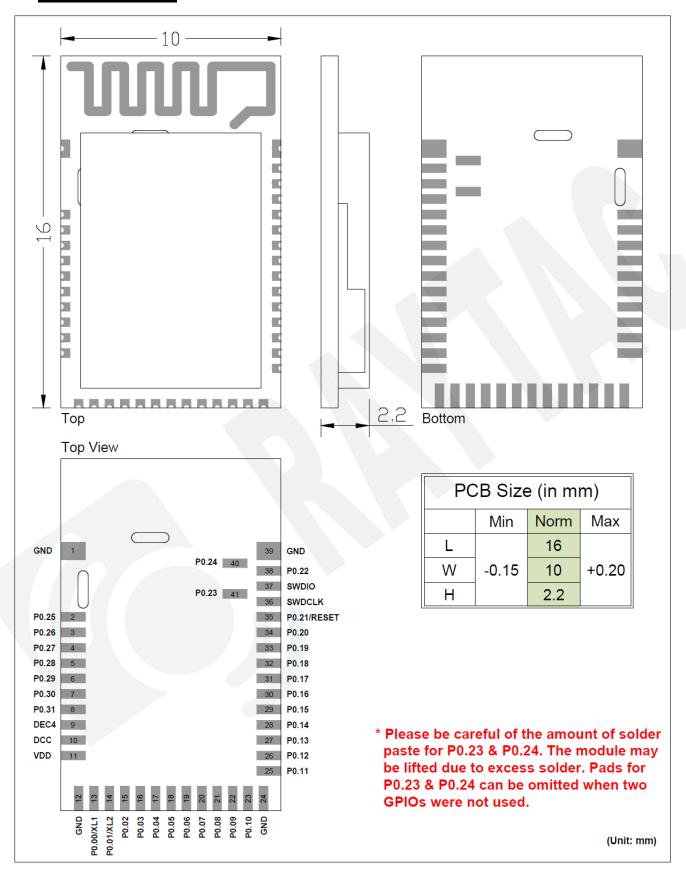
2. Product dimension

2.1. PCB dimensions & pin indication

· MDBT42Q



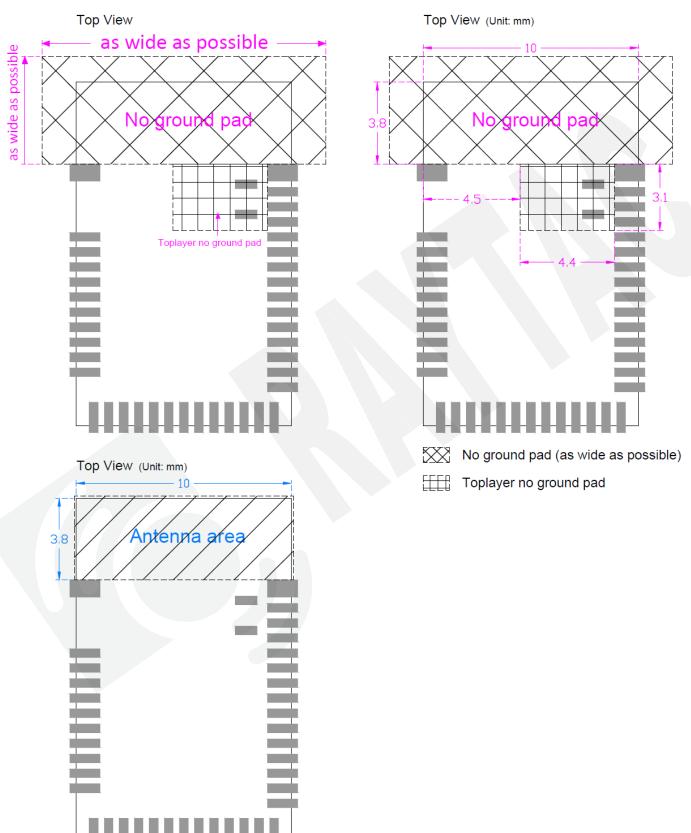
· MDBT42Q-P

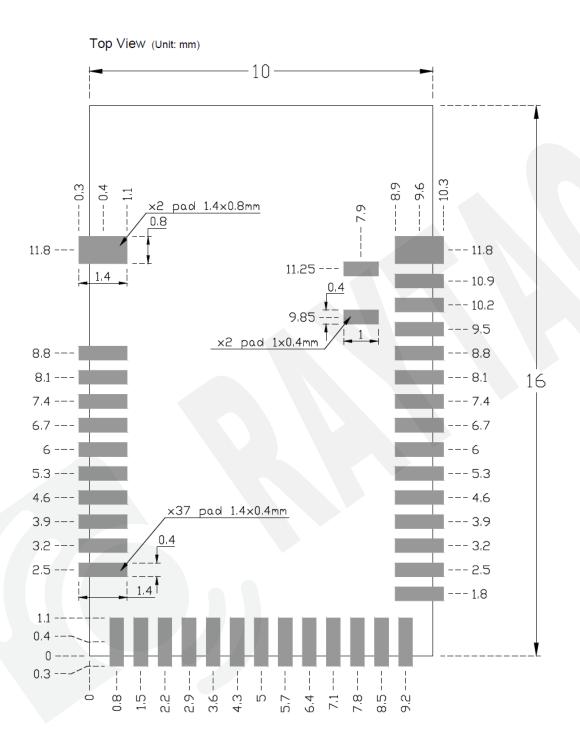


2.2. Recommended layout of solder pad

Antenna area

Graphs are all in Top View, Unit in mm.





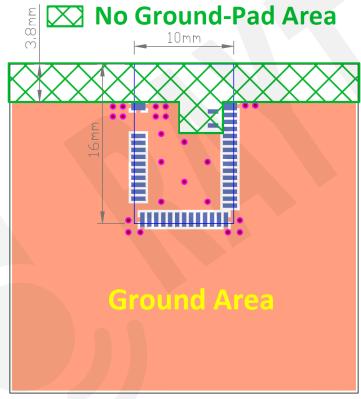
2.3. RF layout suggestion (AKA, antenna keep-out area)

Make sure to keep the "No Ground Pad" as wider as you can regardless of the size of your PCB.

No-Ground Pad should be included in the corresponding position of the antenna in **EACH LAYER**.

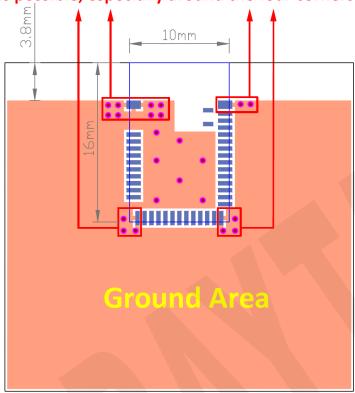
Place the module towards the edge of PCB to have better performance than placing it on the center.

Welcome to send us your layout in PDF for review at sales@raytac.com or your contact at Raytac with title "Layout reviewing – Raytac Model No. – YOUR company's name".



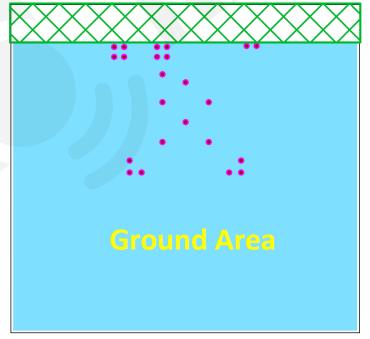
Top View

Please add via holes in GROUND area as many as possible, especially around the four corners.



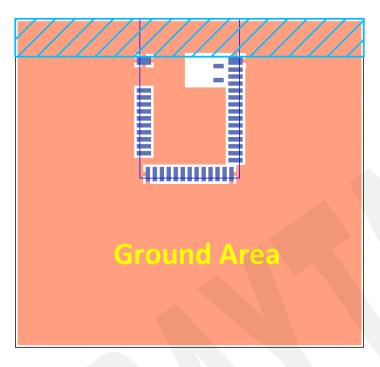
Top View



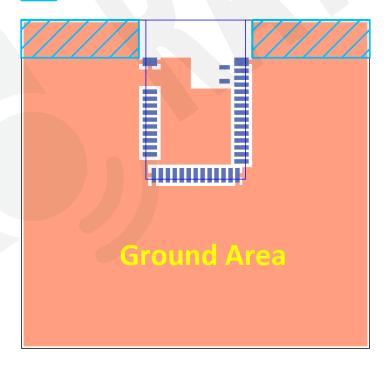


Perpective View









2.4. Footprint & Design guide

Please visit "Support" page of our website to download. The package includes footprint, 2D/3D drawing, reflow graph and recommended spec for external 32.768KHz.

2.5. Pin assignment

	Pin No.	Name	Pin function	Description	
	(1)	GND	Ground	The pad must be connected to a solid ground plane	
(4) P0.27 Digital I/O General-purpose digital I/O (5) P0.28 Digital I/O General-purpose digital I/O AIN4 Analog input SAADC/COMP input (6) P0.29 Digital I/O General-purpose digital I/O AIN5 Analog input SAADC/COMP input (7) P0.30 Digital I/O General-purpose digital I/O AIN6 Analog input SAADC/COMP input (8) P0.31 Digital I/O General-purpose digital I/O AIN7 Analog input SAADC/COMP input (9) DEC4 Power SAADC/COMP input (10) DCC Power DC/DC converter output pin (11) VDD Power Power-supply pin (12) GND Ground The pad must be connected to a solid ground plane (13) P0.00 Digital I/O General-purpose digital I/O XL1 Analog input Connection to 32.768KHz crystal (LFXO) (14) P0.01 Digital I/O General-purpose digital I/O XL2 Analog input Connection to 32.768KHz crystal (LFXO) (15) P0.02 Digital I/O General-purpose digital I/O AIN0 Analog input SAADC/COMP input P0.03 Digital I/O General-purpose digital I/O AIN0 Analog input SAADC/COMP input P0.04 Digital I/O General-purpose digital I/O AIN1 Analog input SAADC/COMP input P0.05 Digital I/O General-purpose digital I/O AIN2 Analog input SAADC/COMP input P0.06 Digital I/O General-purpose digital I/O AIN3 Analog input SAADC/COMP input P0.05 Digital I/O General-purpose digital I/O AIN3 Analog input SAADC/COMP input P0.05 Digital I/O General-purpose digital I/O AIN3 Analog input SAADC/COMP input P0.06 Digital I/O General-purpose digital I/O AIN3 Analog input SAADC/COMP input	(2)	P0.25	Digital I/O	General-purpose digital I/O	
(5) P0.28 Digital I/O General-purpose digital I/O	(3)	P0.26	Digital I/O	General-purpose digital I/O	
AIN4	(4)	P0.27	Digital I/O	General-purpose digital I/O	
AIN4 Analog input SAADC/COMP input P0.29 Digital I/O General-purpose digital I/O AIN5 Analog input SAADC/COMP input P0.30 Digital I/O General-purpose digital I/O AIN6 Analog input SAADC/COMP input (8) P0.31 Digital I/O General-purpose digital I/O AIN7 Analog input SAADC/COMP input (9) DEC4 Power DC/DC converter output from DC/DC converter. Output from 1V3 LDO (10) DCC Power DC/DC converter output pin (11) VDD Power Power-supply pin (12) GND Ground The pad must be connected to a solid ground plane (13) P0.00 Digital I/O General-purpose digital I/O XL1 Analog input Connection to 32.768KHz crystal (LFXO) (14) P0.01 Digital I/O General-purpose digital I/O XL2 Analog input Connection to 32.768KHz crystal (LFXO) P0.02 Digital I/O General-purpose digital I/O AIN0 Analog input SAADC/COMP input P0.03 Digital I/O General-purpose digital I/O AIN1 Analog input SAADC/COMP input P0.04 Digital I/O General-purpose digital I/O AIN2 Analog input SAADC/COMP input P0.05 Digital I/O General-purpose digital I/O AIN3 Analog input SAADC/COMP input P0.06 Digital I/O General-purpose digital I/O AIN3 Analog input SAADC/COMP input P0.05 Digital I/O General-purpose digital I/O AIN3 Analog input SAADC/COMP input P0.06 Digital I/O General-purpose digital I/O AIN3 Analog input SAADC/COMP input	(F)	P0.28	Digital I/O	General-purpose digital I/O	
AIN5	(5)	AIN4	Analog input	SAADC/COMP input	
AINS Analog input SAADC/COMP input P0.30 Digital I/O General-purpose digital I/O AIN6 Analog input SAADC/COMP input (8) P0.31 Digital I/O General-purpose digital I/O AIN7 Analog input SAADC/COMP input (9) DEC4 Power 1V3 regulator supply decoupling. Input from DC/DC converter. Output from 1V3 LDO (10) DCC Power DC/DC converter output pin (11) VDD Power Power-supply pin (12) GND Ground The pad must be connected to a solid ground plane P0.00 Digital I/O General-purpose digital I/O XL1 Analog input Connection to 32.768KHz crystal (LFXO) (14) XL2 Analog input Connection to 32.768KHz crystal (LFXO) (15) P0.02 Digital I/O General-purpose digital I/O AIN0 Analog input SAADC/COMP input (16) AIN1 Analog input SAADC/COMP input (17) P0.04 Digital I/O General-purpose digital I/O AIN2 Analog input SAADC/COMP input P0.05 Digital I/O General-purpose digital I/O AIN3 Analog input SAADC/COMP input P0.05 Digital I/O General-purpose digital I/O AIN3 Analog input SAADC/COMP input P0.05 Digital I/O General-purpose digital I/O AIN3 Analog input SAADC/COMP input P0.06 Digital I/O General-purpose digital I/O AIN3 Analog input SAADC/COMP input P0.05 Digital I/O General-purpose digital I/O AIN3 Analog input SAADC/COMP input P0.06 Digital I/O General-purpose digital I/O AIN3 Analog input SAADC/COMP input	(0)	P0.29	Digital I/O	General-purpose digital I/O	
AIN6 Analog input SAADC/COMP input P0.31 Digital I/O General-purpose digital I/O AIN7 Analog input SAADC/COMP input 1V3 regulator supply decoupling. Input from DC/DC converter. Output from 1V3 LDO DCC Power DC/DC converter output pin (11) VDD Power Power-supply pin (12) GND Ground The pad must be connected to a solid ground plane P0.00 Digital I/O General-purpose digital I/O XL1 Analog input Connection to 32.768KHz crystal (LFXO) XL2 Analog input Connection to 32.768KHz crystal (LFXO) (15) P0.02 Digital I/O General-purpose digital I/O AIN0 Analog input SAADC/COMP input P0.03 Digital I/O General-purpose digital I/O AIN1 Analog input SAADC/COMP input P0.04 Digital I/O General-purpose digital I/O AIN2 Analog input SAADC/COMP input P0.05 Digital I/O General-purpose digital I/O AIN3 Analog input SAADC/COMP input P0.05 Digital I/O General-purpose digital I/O AIN3 Analog input SAADC/COMP input P0.05 Digital I/O General-purpose digital I/O AIN3 Analog input SAADC/COMP input P0.06 Digital I/O General-purpose digital I/O AIN3 Analog input SAADC/COMP input P0.05 Digital I/O General-purpose digital I/O AIN3 Analog input SAADC/COMP input General-purpose digital I/O AIN3 Analog input SAADC/COMP input P0.06 Digital I/O General-purpose digital I/O	(6)	AIN5	Analog input	SAADC/COMP input	
AIN6	/= \	P0.30	Digital I/O	General-purpose digital I/O	
AIN7 Analog input SAADC/COMP input 1V3 regulator supply decoupling. Input from DC/DC converter. Output from 1V3 LDO 100 DCC Power DC/DC converter output pin 1V1 Power Power-supply pin 101 PO.00 Digital I/O General-purpose digital I/O 101 XL1 Analog input Connection to 32.768KHz crystal (LFXO) 102 AIN0 Analog input Connection to 32.768KHz crystal (LFXO) 103 Digital I/O General-purpose digital I/O 104 Connection to 32.768KHz crystal (LFXO) 105 AIN0 Analog input Connection to 32.768KHz crystal (LFXO) 106 AIN0 Analog input SAADC/COMP input 107 AIN1 Analog input SAADC/COMP input 108 PO.04 Digital I/O General-purpose digital I/O 109 AIN2 Analog input SAADC/COMP input 109 PO.05 Digital I/O General-purpose digital I/O 109 AIN3 Analog input SAADC/COMP input 109 PO.06 Digital I/O General-purpose digital I/O 109 General-purpose digital I/O	(7)	AIN6	Analog input	SAADC/COMP input	
AIN7 Analog input SAADC/COMP input 1V3 regulator supply decoupling. Input from DC/DC converter. Output from 1V3 LDO (10) DCC Power DC/DC converter output pin (11) VDD Power Power-supply pin (12) GND Ground The pad must be connected to a solid ground plane P0.00 Digital I/O General-purpose digital I/O XL1 Analog input Connection to 32.768KHz crystal (LFXO) P0.01 Digital I/O General-purpose digital I/O XL2 Analog input Connection to 32.768KHz crystal (LFXO) P0.02 Digital I/O General-purpose digital I/O AIN0 Analog input SAADC/COMP input P0.03 Digital I/O General-purpose digital I/O AIN1 Analog input SAADC/COMP input P0.04 Digital I/O General-purpose digital I/O AIN2 Analog input SAADC/COMP input P0.05 Digital I/O General-purpose digital I/O AIN3 Analog input SAADC/COMP input P0.06 Digital I/O General-purpose digital I/O General-purpose digital I/O General-purpose digital I/O General-purpose digital I/O General-purpose digital I/O General-purpose digital I/O General-purpose digital I/O General-purpose digital I/O General-purpose digital I/O General-purpose digital I/O General-purpose digital I/O General-purpose digital I/O General-purpose digital I/O General-purpose digital I/O General-purpose digital I/O General-purpose digital I/O General-purpose digital I/O General-purpose digital I/O General-purpose digital I/O General-purpose digital I/O	(0)	P0.31	Digital I/O	General-purpose digital I/O	
converter. Output from 1V3 LDO Converter output pin Converter. Output pin Converter. Output pin Converter output pin Converter. Output pin	(8)	AIN7	Analog input	SAADC/COMP input	
(11) VDD Power Power-supply pin (12) GND Ground The pad must be connected to a solid ground plane P0.00 Digital I/O General-purpose digital I/O XL1 Analog input Connection to 32.768KHz crystal (LFXO) P0.01 Digital I/O General-purpose digital I/O XL2 Analog input Connection to 32.768KHz crystal (LFXO) P0.02 Digital I/O General-purpose digital I/O AINO Analog input SAADC/COMP input P0.03 Digital I/O General-purpose digital I/O AIN1 Analog input SAADC/COMP input P0.04 Digital I/O General-purpose digital I/O AIN2 Analog input SAADC/COMP input P0.05 Digital I/O General-purpose digital I/O AIN3 Analog input SAADC/COMP input P0.05 Digital I/O General-purpose digital I/O AIN3 Analog input SAADC/COMP input P0.06 Digital I/O General-purpose digital I/O General-purpose digital I/O General-purpose digital I/O General-purpose digital I/O General-purpose digital I/O General-purpose digital I/O General-purpose digital I/O General-purpose digital I/O General-purpose digital I/O General-purpose digital I/O General-purpose digital I/O	(9)	DEC4	Power		
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XL1 Analog input Connection to 32.768KHz crystal (LFXO) P0.01 Digital I/O General-purpose digital I/O XL2 Analog input Connection to 32.768KHz crystal (LFXO) P0.02 Digital I/O General-purpose digital I/O AINO Analog input SAADC/COMP input P0.03 Digital I/O General-purpose digital I/O AIN1 Analog input SAADC/COMP input P0.04 Digital I/O General-purpose digital I/O AIN2 Analog input SAADC/COMP input P0.05 Digital I/O General-purpose digital I/O AIN3 Analog input SAADC/COMP input P0.06 Digital I/O General-purpose digital I/O General-purpose digital I/O General-purpose digital I/O General-purpose digital I/O General-purpose digital I/O General-purpose digital I/O General-purpose digital I/O General-purpose digital I/O General-purpose digital I/O General-purpose digital I/O	(12)	P0.00	Digital I/O	General-purpose digital I/O	
XL2 Analog input Connection to 32.768KHz crystal (LFXO) P0.02 Digital I/O General-purpose digital I/O AIN0 Analog input SAADC/COMP input P0.03 Digital I/O General-purpose digital I/O AIN1 Analog input SAADC/COMP input P0.04 Digital I/O General-purpose digital I/O AIN2 Analog input SAADC/COMP input P0.05 Digital I/O General-purpose digital I/O AIN3 Analog input SAADC/COMP input P0.06 Digital I/O General-purpose digital I/O General-purpose digital I/O General-purpose digital I/O General-purpose digital I/O General-purpose digital I/O General-purpose digital I/O General-purpose digital I/O General-purpose digital I/O General-purpose digital I/O General-purpose digital I/O	(13)	XL1	Analog input	Connection to 32.768KHz crystal (LFXO)	
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AIN0 Analog input SAADC/COMP input P0.03 Digital I/O General-purpose digital I/O AIN1 Analog input SAADC/COMP input P0.04 Digital I/O General-purpose digital I/O AIN2 Analog input SAADC/COMP input P0.05 Digital I/O General-purpose digital I/O AIN3 Analog input SAADC/COMP input P0.06 Digital I/O General-purpose digital I/O General-purpose digital I/O General-purpose digital I/O General-purpose digital I/O General-purpose digital I/O General-purpose digital I/O General-purpose digital I/O General-purpose digital I/O	(14)	XL2	Analog input	Connection to 32.768KHz crystal (LFXO)	
AIN0 Analog input SAADC/COMP input P0.03 Digital I/O General-purpose digital I/O AIN1 Analog input SAADC/COMP input P0.04 Digital I/O General-purpose digital I/O AIN2 Analog input SAADC/COMP input P0.05 Digital I/O General-purpose digital I/O AIN3 Analog input SAADC/COMP input SAADC/COMP input P0.05 Digital I/O General-purpose digital I/O AIN3 Analog input SAADC/COMP input SAADC/COMP input General-purpose digital I/O General-purpose digital I/O General-purpose digital I/O General-purpose digital I/O		P0.02	Digital I/O	General-purpose digital I/O	
AIN1 Analog input SAADC/COMP input P0.04 Digital I/O General-purpose digital I/O AIN2 Analog input SAADC/COMP input P0.05 Digital I/O General-purpose digital I/O AIN3 Analog input SAADC/COMP input SAADC/COMP input P0.06 Digital I/O General-purpose digital I/O General-purpose digital I/O General-purpose digital I/O	(15)	AIN0	Analog input	SAADC/COMP input	
AIN1 Analog input SAADC/COMP input P0.04 Digital I/O General-purpose digital I/O AIN2 Analog input SAADC/COMP input P0.05 Digital I/O General-purpose digital I/O AIN3 Analog input SAADC/COMP input SAADC/COMP input P0.06 Digital I/O General-purpose digital I/O General-purpose digital I/O General-purpose digital I/O		P0.03	Digital I/O	General-purpose digital I/O	
AIN2 Analog input SAADC/COMP input P0.05 Digital I/O General-purpose digital I/O AIN3 Analog input SAADC/COMP input P0.06 Digital I/O General-purpose digital I/O	(16)	AIN1	Analog input	SAADC/COMP input	
AIN2 Analog input SAADC/COMP input P0.05 Digital I/O General-purpose digital I/O AIN3 Analog input SAADC/COMP input (19) P0.06 Digital I/O General-purpose digital I/O		P0.04	Digital I/O	General-purpose digital I/O	
AIN3 Analog input SAADC/COMP input P0.06 Digital I/O General-purpose digital I/O	(17)	AIN2	Analog input	SAADC/COMP input	
AIN3 Analog input SAADC/COMP input (19) P0.06 Digital I/O General-purpose digital I/O	(18)	P0.05	Digital I/O	General-purpose digital I/O	
		AIN3	Analog input	SAADC/COMP input	
(20) P0.07 Digital I/O General-purpose digital I/O	(19)	P0.06	Digital I/O	General-purpose digital I/O	
	(20)	P0.07	Digital I/O	General-purpose digital I/O	

Pin No.	Name	Pin function	Description	
(21)	P0.08	Digital I/O	General-purpose digital I/O	
(22)	P0.09	Digital I/O	General-purpose digital I/O	
(23)	P0.10	Digital I/O	General-purpose digital I/O	
(24)	GND	Ground	The pad must be connected to a solid ground plane	
(25)	P0.11	Digital I/O	General-purpose digital I/O	
(26)	P0.12	Digital I/O	General-purpose digital I/O	
(27)	P0.13	Digital I/O	General-purpose digital I/O	
(28)	P0.14	Digital I/O	General-purpose digital I/O	
(29)	P0.15	Digital I/O	General-purpose digital I/O	
(30)	P0.16	Digital I/O	General-purpose digital I/O	
(31)	P0.17	Digital I/O	General-purpose digital I/O	
(32)	P0.18	Digital I/O	General-purpose digital I/O	
(33)	P0.19	Digital I/O	General-purpose digital I/O	
(34)	P0.20	Digital I/O	General-purpose digital I/O	
(0.5)	P0.21	Digital I/O	General-purpose digital I/O	
(35)	RESET		Configurable as system RESET pin	
(36)	SWDCLK	Digital input	Serial Wire debug clock input for debug and programming	
(37)	SWDIO	Digital I/O	Serial Wire debug I/O for debug and programming	
(38)	P0.22	Digital I/O	General-purpose digital I/O	
(39)	GND	Ground	The pad must be connected to a solid ground plane	
(40)	P0.24	Digital I/O	General-purpose digital I/O	
(41)	P0.23	Digital I/O	General-purpose digital I/O	

2.6. GPIO located near the radio

Some GPIO have recommended usage. To maximize RF performance, these GPIO are only available to use as **low drive**, **low frequency I/O only**. Wrong usage may lead to undesirable performance. Here is the list of these GPIO:

Low frequency I/O is a signal with a frequency up to 10 KHz. SPI, I2C, UART, PWM are NOT low frequency I/O.

Module Pin	GPIO
2	P0.25
3	P0.26
4	P0.27
5	P0.28
6	P0.29

3. Main chip solution

RF IC	Crystal Frequency
Nordic NRF52811	32MHz

32MHz crystal is already inside the module.

4. Shipment packaging information

Model	Antenna	Photo
MDBT42Q-192KL	Chip/Ceramic	M. Comments (1995)
MDBT42Q-P192KL	PCB/Printed	SE CONTRACTOR OF THE PARTY OF T

- Unit weight of module:

MDBT42Q-192KL: 0.64 g (\pm 0.02 g) ; MDBT42Q-P192KL: 0.62 g (\pm 0.02 g)

- Packaging type: Anti-static tray or Tape & Reel

	Tray	Tape & Reel	
MPQ (Min. Package Q'ty)	88 pcs per tray	1,500 pcs per reel	
Carton Contents (per carton)	1,760 pcs	1,500 pcs	
Carton Dimension (L) x (W) x (H) cm	37 x 21 x 13	37 x 36 x 6	
Gross Weight	about 2.8 kgs	about 1.9 kgs	

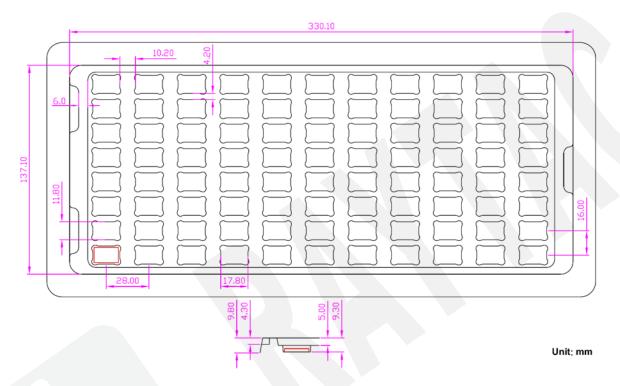
4.1. Marking on metal shield

4.2. Packaging info

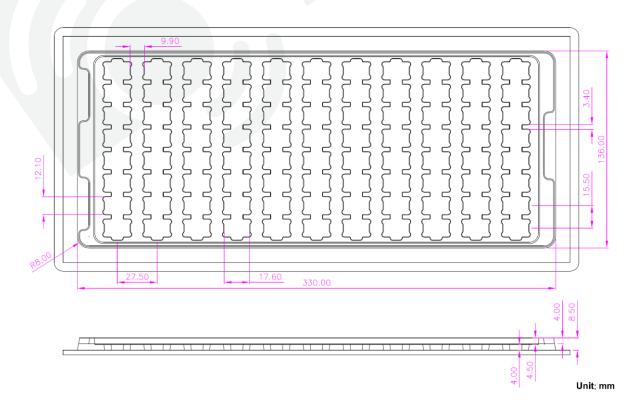
4.2.1. Tray packaging

Anti-static tray is specifically designed for mass production. It can be used directly on SMT automatic machine.

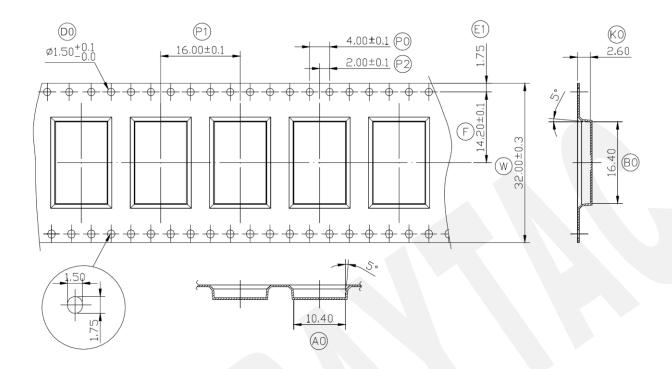
Before July 1st, 2022



After July 1st, 2022



4.2.2. Reel packaging



W	32.00	±0.30
P1	16.00	±0.10
E1	1.75	±0.10
F	14.20	±0.10
D0	1.50	+0.1/-0
P0	4.00	±0.10
P2	2.00	±0.10
A0	10.40	±0.10
В0	16.40	±0.10
K0	2.60	±0.10
Т	0.30	±0.05

4.3. Order code

Each model has two options of packaging. Please use following part no. when placing order to us.

Model	Tray	Tape & Reel	
MDBT42Q-192KL	MD-240A2-S52	MD-240A2-S52R	
MDBT42Q-P192KL	MD-240A2-S53	MD-240A2-S53R	

MPQ of Reel packaging is 1,500 pcs and Tray packaging is 88 pcs.

5. Specification

Any technical spec shall refer to Nordic's official documents as final reference. Contents below are from "nRF52811 Product Specification v1.2", visit the link to view full spec.

5.1. Absolute maximum ratings

	Note	Min.	Max.	Unit
Supply voltages				
VDD		-0.3	+3.9	V
VSS			0	V
I/O pin voltage				
$V_{I/O}$, VDD $\leq 3.6 \text{ V}$		-0.3	VDD + 0.3	V
V _{I/O} , VDD > 3.6 V		-0.3	3.9	V
Radio				
RF input level			10	dBm
Environmental QFN package				
Storage temperature		-40	+125	°C
MSL	Moisture Sensitivity Level		2	
ESD HBM	Human Body Model		3	kV
ESD HBM Class	Human Body Model Class		2	
ESD CDM	Charged Device Model		1	kV
Flash memory				
Endurance		10 000		Write/erase cycles
Retention at 85 °C		10		years

5.2. Operation conditions

Symbol	Parameter	Notes	Min.	Nom.	Max.	Units
VDD	Supply voltage, independent of DCDC enable		1.7	3.0	3.6	V
t _{R_VDD}	Supply rise time (0 V to 1.7 V)				60	ms
TA	Operating temperature		-40	25	85	°C

Important: The on-chip power-on reset circuitry may not function properly for rise times longer than the specified maximum.

5.3. Electrical specifications

5.3.1. General radio characteristics

Symbol	Description	Min.	Тур.	Max.	Units
f_{OP}	Operating frequencies	2360		2500	MHz
f _{PLL,CH,SP}	PLL channel spacing		1		MHz
f _{DELTA,1M}	Frequency deviation @ 1 Mbps		±170		kHz
f _{DELTA,BLE,1M}	Frequency deviation @ BLE 1 Mbps		±250		kHz
f _{DELTA,2M}	Frequency deviation @ 2 Mbps		±320		kHz
f _{DELTA,BLE,2M}	Frequency deviation @ BLE 2 Mbps		±500		kHz
fsk _{BPS}	On-the-air data rate	125		2000	kbps
f _{chip, IEEE 802.15.4}	Chip rate in IEEE 802.15.4 mode		2000		kchip/s

5.3.2. Radio current consumption (Transmitter)

ITX,PLUS4dBM,DCDC TX only run current (DC/DC, 3 V) PRF = +4 dBm 7.0 mA ITX,PLUS4dBM TX only run current PRF = +4 dBm 15.4 mA ITX,DdBM,DCDC TX only run current (DC/DC, 3 V)PRF = 0 dBm 4.6 mA ITX,DdBM TX only run current PRF = 0 dBm 10.1 mA ITX,MINUS4dBM,DCDC TX only run current DC/DC, 3 V PRF = -4 dBm 3.6 mA ITX,MINUS4dBM TX only run current DC/DC, 3 V PRF = -8 dBm 3.2 mA ITX,MINUS8dBM,DCDC TX only run current DC/DC, 3 V PRF = -12 dBm 2.9 mA ITX,MINUS12dBM,DCDC TX only run current DC/DC, 3 V PRF = -12 dBm 6.2 mA ITX,MINUS12dBM TX only run current DC/DC, 3 V PRF = -16 dBm 2.7 mA ITX,MINUS16dBM TX only run current DC/DC, 3 V PRF = -20 dBm 5.7 mA ITX,MINUS20dBM,DCDC TX only run current DC/DC, 3 V PRF = -20 dBm 5.4 mA ITX,MINUS20dBM TX only run current DC/DC, 3 V PRF = -40 dBm 5.4 mA ITX,MINUS40dBM TX only run current DC/DC, 3 V PRF = -40 dBm 2.1 mA ITX,MINUS40dBM TX	Symbol	Description	Min.	Тур.	Max.	Units
$\begin{array}{llllllllllllllllllllllllllllllllllll$	I _{TX,PLUS4dBM,DCDC}	TX only run current (DC/DC, 3 V) P_{RF} = +4 dBm		7.0		mA
$\begin{array}{llllllllllllllllllllllllllllllllllll$	I _{TX,PLUS4dBM}	TX only run current P _{RF} = +4 dBm		15.4		mA
$\begin{array}{llllllllllllllllllllllllllllllllllll$	I _{TX,0dBM,DCDC}	TX only run current (DC/DC, 3 V)P _{RF} = 0 dBm		4.6		mA
$\begin{array}{llllllllllllllllllllllllllllllllllll$	I _{TX,0dBM}	TX only run current P _{RF} = 0 dBm		10.1		mA
$\begin{array}{llllllllllllllllllllllllllllllllllll$	I _{TX,MINUS4dBM,DCDC}	TX only run current DC/DC, 3 V P _{RF} = -4 dBm		3.6		mA
$I_{TX,MINUS8dBM} \qquad TX \text{ only run current } P_{RF} = -8 \text{ dBm} \qquad \qquad 6.8 \qquad \text{mA}$ $I_{TX,MINUS12dBM,DCDC} \qquad TX \text{ only run current } DC/DC, 3 \text{ V } P_{RF} = -12 \text{ dBm} \qquad \qquad 2.9 \qquad \text{mA}$ $I_{TX,MINUS12dBM} \qquad TX \text{ only run current } P_{RF} = -12 \text{ dBm} \qquad \qquad 6.2 \qquad \text{mA}$ $I_{TX,MINUS16dBM,DCDC} \qquad TX \text{ only run current } DC/DC, 3 \text{ V } P_{RF} = -16 \text{ dBm} \qquad \qquad 2.7 \qquad \text{mA}$ $I_{TX,MINUS16dBM} \qquad TX \text{ only run current } P_{RF} = -16 \text{ dBm} \qquad \qquad 5.7 \qquad \text{mA}$ $I_{TX,MINUS20dBM,DCDC} \qquad TX \text{ only run current } DC/DC, 3 \text{ V } P_{RF} = -20 \text{ dBm} \qquad \qquad 2.5 \qquad \text{mA}$ $I_{TX,MINUS20dBM} \qquad TX \text{ only run current } P_{RF} = -20 \text{ dBm} \qquad \qquad 5.4 \qquad \text{mA}$ $I_{TX,MINUS20dBM,DCDC} \qquad TX \text{ only run current } DC/DC, 3 \text{ V } P_{RF} = -40 \text{ dBm} \qquad \qquad 2.1 \qquad \text{mA}$ $I_{TX,MINUS40dBM,DCDC} \qquad TX \text{ only run current } P_{RF} = -40 \text{ dBm} \qquad \qquad 4.3 \qquad \text{mA}$ $I_{TX,MINUS40dBM} \qquad TX \text{ only run current } P_{RF} = -40 \text{ dBm} \qquad \qquad 4.3 \qquad \text{mA}$	I _{TX,MINUS4dBM}	TX only run current P _{RF} = -4 dBm		7.8		mA
$\begin{split} & I_{TX,MINUS12dBM,DCDC} & TX \text{ only run current DC/DC, 3 V P}_{RF} = -12 \text{ dBm} & 2.9 & \text{mA} \\ & I_{TX,MINUS12dBM} & TX \text{ only run current P}_{RF} = -12 \text{ dBm} & 6.2 & \text{mA} \\ & I_{TX,MINUS16dBM,DCDC} & TX \text{ only run current DC/DC, 3 V P}_{RF} = -16 \text{ dBm} & 2.7 & \text{mA} \\ & I_{TX,MINUS16dBM} & TX \text{ only run current P}_{RF} = -16 \text{ dBm} & 5.7 & \text{mA} \\ & I_{TX,MINUS20dBM,DCDC} & TX \text{ only run current DC/DC, 3 V P}_{RF} = -20 \text{ dBm} & 2.5 & \text{mA} \\ & I_{TX,MINUS20dBM} & TX \text{ only run current P}_{RF} = -20 \text{ dBm} & 5.4 & \text{mA} \\ & I_{TX,MINUS20dBM,DCDC} & TX \text{ only run current DC/DC, 3 V P}_{RF} = -40 \text{ dBm} & 2.1 & \text{mA} \\ & I_{TX,MINUS40dBM} & TX \text{ only run current P}_{RF} = -40 \text{ dBm} & 4.3 & \text{mA} \\ & I_{TX,MINUS40dBM} & TX \text{ only run current P}_{RF} = -40 \text{ dBm} & 4.3 & \text{mA} \\ & I_{TX,MINUS40dBM} & TX \text{ only run current P}_{RF} = -40 \text{ dBm} & 4.3 & \text{mA} \\ & I_{TX,MINUS40dBM} & TX \text{ only run current P}_{RF} = -40 \text{ dBm} & 4.3 & \text{mA} \\ & I_{TX,MINUS40dBM} & TX \text{ only run current P}_{RF} = -40 \text{ dBm} & 4.3 & \text{mA} \\ & I_{TX,MINUS40dBM} & $	I _{TX,MINUS8dBM,DCDC}	TX only run current DC/DC, 3 V P _{RF} = -8 dBm		3.2		mA
$I_{TX,MINUS12dBM} \qquad TX \text{ only run current P}_{RF} = -12 \text{ dBm} \qquad \qquad 6.2 \qquad \text{mA}$ $I_{TX,MINUS16dBM,DCDC} \qquad TX \text{ only run current DC/DC, 3 V P}_{RF} = -16 \text{ dBm} \qquad \qquad 2.7 \qquad \text{mA}$ $I_{TX,MINUS16dBM} \qquad TX \text{ only run current P}_{RF} = -16 \text{ dBm} \qquad \qquad 5.7 \qquad \text{mA}$ $I_{TX,MINUS20dBM,DCDC} \qquad TX \text{ only run current DC/DC, 3 V P}_{RF} = -20 \text{ dBm} \qquad \qquad 2.5 \qquad \text{mA}$ $I_{TX,MINUS20dBM} \qquad TX \text{ only run current P}_{RF} = -20 \text{ dBm} \qquad \qquad 5.4 \qquad \text{mA}$ $I_{TX,MINUS40dBM,DCDC} \qquad TX \text{ only run current DC/DC, 3 V P}_{RF} = -40 \text{ dBm} \qquad \qquad 2.1 \qquad \text{mA}$ $I_{TX,MINUS40dBM} \qquad TX \text{ only run current P}_{RF} = -40 \text{ dBm} \qquad \qquad 4.3 \qquad \text{mA}$	I _{TX,MINUS8dBM}	TX only run current P _{RF} = -8 dBm		6.8		mA
$I_{TX,MINUS16dBM,DCDC} TX \text{ only run current DC/DC, 3 V P}_{RF} = -16 \text{ dBm} \qquad \qquad 2.7 \qquad \text{mA}$ $I_{TX,MINUS16dBM} \qquad TX \text{ only run current P}_{RF} = -16 \text{ dBm} \qquad \qquad 5.7 \qquad \text{mA}$ $I_{TX,MINUS20dBM,DCDC} \qquad TX \text{ only run current DC/DC, 3 V P}_{RF} = -20 \text{ dBm} \qquad \qquad 2.5 \qquad \text{mA}$ $I_{TX,MINUS20dBM} \qquad TX \text{ only run current P}_{RF} = -20 \text{ dBm} \qquad \qquad 5.4 \qquad \text{mA}$ $I_{TX,MINUS40dBM,DCDC} \qquad TX \text{ only run current DC/DC, 3 V P}_{RF} = -40 \text{ dBm} \qquad \qquad 2.1 \qquad \text{mA}$ $I_{TX,MINUS40dBM} \qquad TX \text{ only run current P}_{RF} = -40 \text{ dBm} \qquad \qquad 4.3 \qquad \text{mA}$	I _{TX,MINUS12dBM,DCDC}	TX only run current DC/DC, 3 V P _{RF} = -12 dBm		2.9		mA
$I_{TX,MINUS16dBM} \qquad TX \text{ only run current P}_{RF} = -16 \text{ dBm} \qquad \qquad 5.7 \qquad \text{mA}$ $I_{TX,MINUS20dBM,DCDC} \qquad TX \text{ only run current DC/DC, 3 V P}_{RF} = -20 \text{ dBm} \qquad \qquad 2.5 \qquad \text{mA}$ $I_{TX,MINUS20dBM} \qquad TX \text{ only run current P}_{RF} = -20 \text{ dBm} \qquad \qquad 5.4 \qquad \text{mA}$ $I_{TX,MINUS40dBM,DCDC} \qquad TX \text{ only run current DC/DC, 3 V P}_{RF} = -40 \text{ dBm} \qquad \qquad 2.1 \qquad \text{mA}$ $I_{TX,MINUS40dBM} \qquad TX \text{ only run current P}_{RF} = -40 \text{ dBm} \qquad \qquad 4.3 \qquad \text{mA}$	I _{TX,MINUS12dBM}	TX only run current P _{RF} = -12 dBm		6.2		mA
$I_{TX,MINUS20dBM,DCDC} TX \text{ only run current DC/DC, 3 V P}_{RF} = -20 \text{ dBm} \qquad \qquad 2.5 \qquad \text{mA}$ $I_{TX,MINUS20dBM} \qquad TX \text{ only run current P}_{RF} = -20 \text{ dBm} \qquad \qquad 5.4 \qquad \text{mA}$ $I_{TX,MINUS40dBM,DCDC} TX \text{ only run current DC/DC, 3 V P}_{RF} = -40 \text{ dBm} \qquad \qquad 2.1 \qquad \text{mA}$ $I_{TX,MINUS40dBM} \qquad TX \text{ only run current P}_{RF} = -40 \text{ dBm} \qquad \qquad 4.3 \qquad \text{mA}$	I _{TX,MINUS16dBM,DCDC}	TX only run current DC/DC, 3 V P_{RF} = -16 dBm		2.7		mA
$I_{TX,MINUS20dBM} \qquad TX \text{ only run current } P_{RF} = -20 \text{ dBm} \qquad \qquad 5.4 \qquad \text{mA}$ $I_{TX,MINUS40dBM,DCDC} \qquad TX \text{ only run current DC/DC, 3 V } P_{RF} = -40 \text{ dBm} \qquad \qquad 2.1 \qquad \text{mA}$ $I_{TX,MINUS40dBM} \qquad TX \text{ only run current } P_{RF} = -40 \text{ dBm} \qquad \qquad 4.3 \qquad \text{mA}$	I _{TX,MINUS16dBM}	TX only run current P _{RF} = -16 dBm		5.7		mA
$I_{TX,MINUS40dBM,DCDC}$ TX only run current DC/DC, 3 V P_{RF} = -40 dBm 2.1 mA $I_{TX,MINUS40dBM}$ TX only run current P_{RF} = -40 dBm 4.3 mA	I _{TX,MINUS20dBM,DCDC}	TX only run current DC/DC, 3 V P_{RF} = -20 dBm		2.5		mA
I _{TX,MINUS40dBM} TX only run current P _{RF} = -40 dBm 4.3 mA	I _{TX,MINUS20dBM}	TX only run current P _{RF} = -20 dBm		5.4		mA
	I _{TX,MINUS40dBM,DCDC}	TX only run current DC/DC, 3 V P _{RF} = -40 dBm		2.1		mA
I _{START,TX,DCDC} TX start-up current DC/DC, 3 V, P _{RF} = 4 dBm mA	I _{TX,MINUS40dBM}	TX only run current P _{RF} = -40 dBm		4.3		mA
	I _{START,TX,DCDC}	TX start-up current DC/DC, 3 V, P _{RF} = 4 dBm				mA
$I_{START,TX}$ TX start-up current, $P_{RF} = 4 \text{ dBm}$ mA	I _{START,TX}	TX start-up current, P _{RF} = 4 dBm				mA

5.3.3. Radio current consumption (Receiver)

Symbol	Description	Min.	Тур.	Max.	Units
I _{RX,1M,DCDC}	RX only run current (DC/DC, 3 V) 1 Mbps/1 Mbps BLE		4.6		mA
I _{RX,1M}	RX only run current (LDO, 3 V) 1 Mbps/1 Mbps BLE		10.0		mA
I _{RX,2M,DCDC}	RX only run current (DC/DC, 3 V) 2 Mbps/2 Mbps BLE		5.2		mA
I _{RX,2M}	RX only run current (LDO, 3 V) 2 Mbps/2 Mbps BLE		11.2		mA
I _{START,RX,1M,DCDC}	RX start-up current (DC/DC, 3 V) 1 Mbps/1 Mbps BLE		3.5		mA
I _{START,RX,1M}	RX start-up current 1 Mbps/1 Mbps BLE		6.7		mA

5.3.4. Transmitter specification

Symbol	Description	Min.	Тур.	Max.	Units
P _{RF}	Maximum output power		4.0		dBm
P _{RFC}	RF power control range		24		dB
P _{RFCR}	RF power accuracy			±4	dB
P _{RF1,1}	1st Adjacent Channel Transmit Power 1 MHz (1 Mbps)		-25		dBc
P _{RF2,1}	2nd Adjacent Channel Transmit Power 2 MHz (1 Mbps)		-50		dBc
P _{RF1,2}	1st Adjacent Channel Transmit Power 2 MHz (2 Mbps)		-25		dBc
P _{RF2,2}	2nd Adjacent Channel Transmit Power 4 MHz (2 Mbps)		-50		dBc
E _{vm}	Error vector magnitude IEEE 802.15.4		12		%rms
P _{harm2nd} , IEEE 802.15.4	2nd harmonics in IEEE 802.15.4 mode		-45		dBm
P _{harm3rd} , IEEE 802.15.4	3rd harmonics in IEEE 802.15.4				dBm

5.3.5. Receiver operation

Symbol	Description	Min.	Тур.	Max.	Units
P _{RX,MAX}	Maximum received signal strength at < 0.1% PER		0		dBm
P _{SENS,IT,1M}	Sensitivity, 1 Mbps nRF mode ideal transmitter ¹		-94		dBm
P _{SENS,IT,2M}	Sensitivity, 2 Mbps nRF mode ideal transmitter ²		-91		dBm
P _{SENS,IT,SP,1M,BLE}	Sensitivity, 1 Mbps BLE ideal transmitter, packet length ≤ 37 bytes BER=1E-3 ³		-97		dBm
P _{SENS,IT,LP,1M,BLE}	Sensitivity, 1 Mbps BLE ideal transmitter, packet length ≥ 128		-96		dBm
	bytes BER=1E-4 ⁴				

Symbol	Description	Min.	Тур.	Max.	Units
P _{SENS,IT,SP,2M,BLE}	Sensitivity, 2 Mbps BLE ideal transmitter, packet length \leq 37		-94		dBm
	bytes				
P _{SENS,IT,BLE LE125k}	Sensitivity, 125 kbps BLE mode		-104		dBm
P _{SENS,IT,BLE LE500k}	Sensitivity, 500 kbps BLE mode		-100		dBm
P _{SENS,IEEE 802.15.4}	Sensitivity in IEEE 802.15.4 mode		-101		dBm

- 1. Typical sensitivity applies when ADDR0 is used for receiver address correlation. When ADDR[1...7] are used for receiver address correlation, the typical sensitivity for this mode is degraded by 3 dB.
- 2. Same as remark 1.
- 3. As defined in the Bluetooth Core Specification v4.0 Volume 6: Core System Package (Low Energy Controller Volume)
- 4. Equivalent BER limit < 10E-04.

5.3.6. RX selectivity

Symbol	Description	Min.	Тур.	Max.	Units
C/I _{1M,co-channel}	1Mbps mode, Co-Channel interference		9		dB
C/I _{1M,-1MHz}	1 Mbps mode, Adjacent (-1 MHz) interference		-2		dB
C/I _{1M,+1MHz}	1 Mbps mode, Adjacent (+1 MHz) interference		-10		dB
C/I _{1M,-2MHz}	1 Mbps mode, Adjacent (-2 MHz) interference		-19		dB
C/I _{1M,+2MHz}	1 Mbps mode, Adjacent (+2 MHz) interference		-42		dB
C/I _{1M,-3MHz}	1 Mbps mode, Adjacent (-3 MHz) interference		-38		dB
C/I _{1M,+3MHz}	1 Mbps mode, Adjacent (+3 MHz) interference		-48		dB
C/I _{1M,±6MHz}	1 Mbps mode, Adjacent (≥6 MHz) interference		-50		dB
C/I _{1MBLE,co-channel}	1 Mbps BLE mode, Co-Channel interference		6		dB
C/I _{1MBLE,-1MHz}	1 Mbps BLE mode, Adjacent (-1 MHz) interference		-2		dB
C/I _{1MBLE,+1MHz}	1 Mbps BLE mode, Adjacent (+1 MHz) interference		-9		dB
C/I _{1MBLE,-2MHz}	1 Mbps BLE mode, Adjacent (-2 MHz) interference		-22		dB
C/I _{1MBLE,+2MHz}	1 Mbps BLE mode, Adjacent (+2 MHz) interference		-46		dB
C/I _{1MBLE,>3MHz}	1 Mbps BLE mode, Adjacent (≥3 MHz) interference		-50		dB
C/I _{1MBLE,image}	Image frequency interference		-22		dB
C/I _{1MBLE,image,1MHz}	Adjacent (1 MHz) interference to in-band image frequency		-35		dB
C/I _{2M,co-channel}	2 Mbps mode, Co-Channel interference		10		dB
C/I _{2M,-2MHz}	2 Mbps mode, Adjacent (-2 MHz) interference		6		dB
C/I _{2M,+2MHz}	2 Mbps mode, Adjacent (+2 MHz) interference		-14		dB
C/I _{2M,-4MHz}	2 Mbps mode, Adjacent (-4 MHz) interference		-20		dB
C/I _{2M,+4MHz}	2 Mbps mode, Adjacent (+4 MHz) interference		-44		dB
C/I _{2M,-6MHz}	2 Mbps mode, Adjacent (-6 MHz) interference		-42		dB
C/I _{2M,+6MHz}	2 Mbps mode, Adjacent (+6 MHz) interference		-47		dB
C/I _{2M,≥12MHz}	2 Mbps mode, Adjacent (≥12 MHz) interference		-52		dB

Symbol	Description	Min.	Тур.	Max.	Units
C/I _{2MBLE,co-channel}	2 Mbps BLE mode, Co-Channel interference		6		dB
C/I _{2MBLE,±2MHz}	2 Mbps BLE mode, Adjacent (±2 MHz) interference		-2		dB
C/I _{2MBLE,±4MHz}	2 Mbps BLE mode, Adjacent (±4 MHz) interference		-48		dB
C/I _{2MBLE,≥6MHz}	2 Mbps BLE mode, Adjacent (≥6 MHz) interference		-50		dB
C/I _{2MBLE,image}	Image frequency interference		-29		dB
C/I _{2MBLE,image} , 2MHz	Adjacent (2 MHz) interference to in-band image frequency		-44		dB
C/I _{125k BLE LR,co-channel}	125 kbps BLE LR mode, Co-Channel interference		4		dB
C/I _{125k BLE LR,-1MHz}	125 kbps BLE LR mode, Adjacent (-1 MHz) interference		-9		dB
C/I _{125k BLE LR,+1MHz}	125 kbps BLE LR mode, Adjacent (+1 MHz) interference		-16		dB
C/I _{125k BLE LR,-2MHz}	125 kbps BLE LR mode, Adjacent (-2 MHz) interference		-30		dB
C/I _{125k BLE LR,+2MHz}	125 kbps BLE LR mode, Adjacent (+2 MHz) interference		-50		dB
C/I _{125k BLE LR,>3MHz}	125 kbps BLE LR mode, Adjacent (≥3 MHz) interference		-55		dB
C/I _{125k BLE LR,image}	Image frequency interference		-30		dB
C/I _{IEEE 802.15.4,-5MHz}	IEEE 802.15.4 mode, Adjacent (-5 MHz) rejection		33		dB
C/I _{IEEE 802.15.4,+5MHz}	IEEE 802.15.4 mode, Adjacent (+5 MHz) rejection		38		dB
C/I _{IEEE 802.15.4, 10MHz}	IEEE 802.15.4 mode, Alternate (10 MHz) rejection		48		dB

5.3.7. RX intermodulation

Symbol	Description	Min.	Тур.	Max.	Units
P _{IMD,5TH,1M}	IMD performance, 1 Mbps, 5th offset channel, packet length		-33		dBm
	≤ 37 bytes				
P _{IMD,5TH,1M,BLE}	IMD performance, BLE 1 Mbps, 5th offset channel, packet		-30		dBm
	length ≤ 37 bytes				
P _{IMD,5TH,2M}	IMD performance, 2 Mbps, 5th offset channel, packet length		-33		dBm
	≤ 37 bytes				
P _{IMD,5TH,2M,BLE}	IMD performance, BLE 2 Mbps, 5th offset channel, packet		-31		dBm
	length ≤ 37 bytes				

Remark: Desired signal level at PIN= -64 dBm. Two interferers with equal input power are used.

The interferer closest in frequency is not modulated, the other interferer is modulated equal with the desired signal. The input power of the interferers where the sensitivity equals BER = 0.1% is presented.

5.3.8. RSSI specifications

Symbol	Description	Min.	Тур.	Max.	Units
RSSI _{ACC}	RSSI accuracy valid range -90 to -20 dBm		±2		dB
RSSI _{RESOLUTION}	RSSI resolution		1		dB
RSSI _{PERIOD}	RSSI sampling time from RSSI_START task		0.25		μs
RSSI _{SETTLE}	RSSI settling time after signal level change		15		μs

5.3.9. Radio timing parameters

Symbol	Description	Min.	Тур.	Max.	Units
t _{TXEN,BLE,1M}	Time between TXEN task and READY event after channel	140		140	μs
	FREQUENCY configured (1 Mbps BLE and 150 μs TIFS)				
t _{TXEN,FAST,BLE,1M}	Time between TXEN task and READY event after channel	40		40	μs
	FREQUENCY configured (1 Mbps BLE with fast ramp-up and				
	150 μs TIFS)				
t _{TXDIS,BLE,1M}	When in TX, delay between DISABLE task and DISABLED	6		6	μs
	event for MODE = Nrf_1Mbit and MODE = Ble_1Mbit				
t _{RXEN,BLE,1M}	Time between the RXEN task and READY event after channel	140		140	μѕ
	FREQUENCY configured (1 Mbps BLE)				
t _{RXEN,FAST,BLE,1M}	Time between the RXEN task and READY event after channel	40		40	μs
	FREQUENCY configured (1 Mbps BLE with fast ramp-up)				
t _{RXDIS,BLE,1M}	When in RX, delay between DISABLE task and DISABLED	0		0	μѕ
	event for MODE = Nrf_1Mbit and MODE = Ble_1Mbit				
t _{TXDIS,BLE,2M}	When in TX, delay between DISABLE task and DISABLED	4		4	μѕ
	event for MODE = Nrf_2Mbit and MODE = Ble_2Mbit				
t _{RXDIS,BLE,2M}	When in RX, delay between DISABLE task and DISABLED	0		0	μs
	event for MODE = Nrf_2Mbit and MODE = Ble_2Mbit				
t _{TXEN} ,IEEE 802.15.4	Time between TXEN task and READY event after channel	130		130	μs
	FREQUENCY configured (IEEE 802.15.4)				
t _{TXEN} ,FAST,IEEE 802.15.4	Time between TXEN task and READY event after channel	40		40	μs
	FREQUENCY configured (IEEE 802.15.4 with fast ramp-up)				
t _{TXDIS} ,IEEE 802.15.4	When in TX, delay between DISABLE task and DISABLED	21		21	μs
	event (IEEE 802.15.4)				
t _{RXEN,IEEE} 802.15.4	Time between the RXEN task and READY event after channel	130		130	μs
	FREQUENCY configured (IEEE 802.15.4)				
t _{RXEN} ,FAST,IEEE 802.15.4	Time between the RXEN task and READY event after channel	40		40	μs
	FREQUENCY configured (IEEE 802.15.4 with fast ramp-up)				
t _{RXDIS,IEEE 802.15.4}	When in RX, delay between DISABLE task and DISABLED	0.5		0.5	μs
	event (IEEE 802.15.4)				
t _{RX-to-TX} turnaround	Maximum TX-to-RX or RX-to-TX turnaround time in IEEE 802.15.4 mode		40		μs

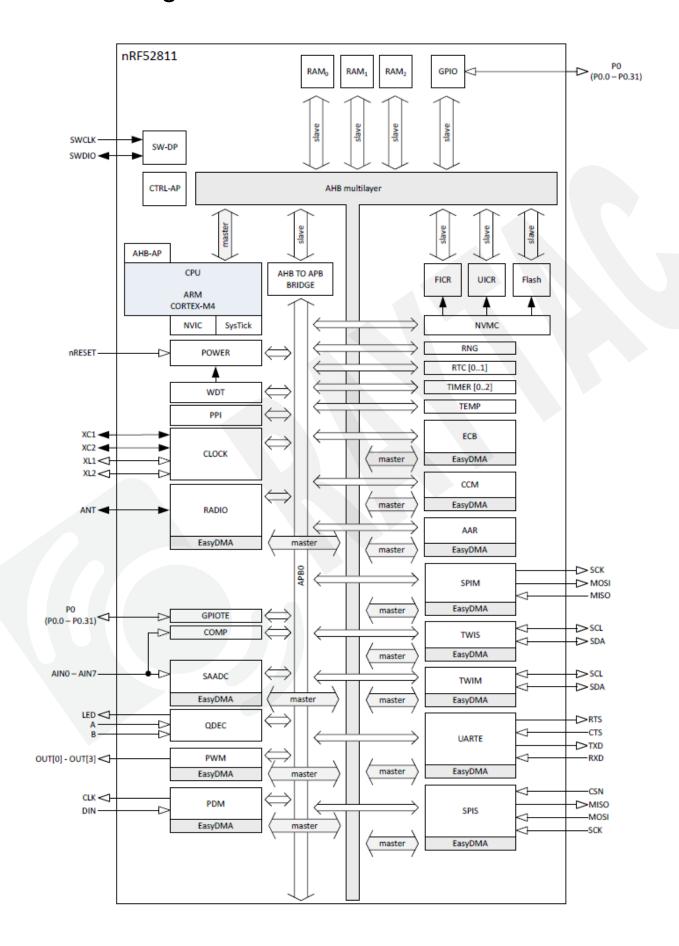
5.3.10. CPU

Symbol	Description	Min.	Тур.	Max.	Units
W _{FLASH}	CPU wait states, running from flash	0		2	
W _{RAM}	CPU wait states, running from RAM			0	
CM _{FLASH}	CoreMark ¹ , running from flash		144		CoreMark
CM _{FLASH/MHz}	CoreMark per MHz, running from flash		2.25		Corel
					MHz
CM _{FLASH/mA}	CoreMark per mA, running from flash, DCDC 3V		65		CoreMark/mA

5.3.11. Power management

Symbol	Description	Min.	Тур.	Max.	Units
ION_RAMOFF_EVENT	System ON, No RAM retention, Wake on any event		0.6		μΑ
I _{ON_RAMON_EVENT}	System ON, Full 24 kB RAM retention, Wake on any event		0.8		μΑ
ION_RAMON_POF	System ON, Full 24 kB RAM retention, Wake on any event,		0.8		μΑ
	Power fail comparator enabled				
I _{ON_RAMON_GPIOTE}	System ON, Full 24 kB RAM retention, Wake on GPIOTE input		3.3		μΑ
	(Event mode)				
ION_RAMON_GPIOTEPOR	RTSystem ON, Full 24 kB RAM retention, Wake on GPIOTE		0.8		μА
	PORT event				
I _{ON_RAMON_RTC}	System ON, Full 24 kB RAM retention, Wake on RTC (running		1.5		μА
	from LFRC clock)				
ION_RAMOFF_RTC	System ON, No RAM retention, Wake on RTC (running from		1.4		μА
	LFRC clock)				
ION_RAMON_RTC_LFXO	System ON, Full 24 kB RAM retention, Wake on RTC (running		1.1		μΑ
	from LFXO clock)				
ION_RAMOFF_RTC_LFXO	System ON, No RAM retention, Wake on RTC (running from		1.0		μА
	LFXO clock)				
I _{OFF_RAMOFF_RESET}	System OFF, No RAM retention, Wake on reset		0.3		μΑ
OFF_RAMON_RESET	System OFF, Full 24 kB RAM retention, Wake on reset		0.5		μА

6. Block diagram

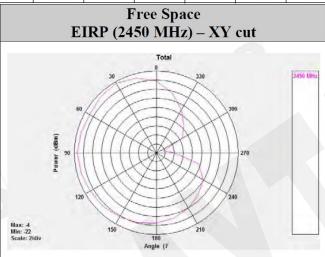


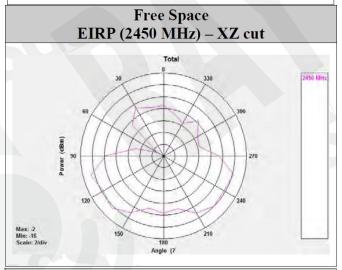
7. Antenna

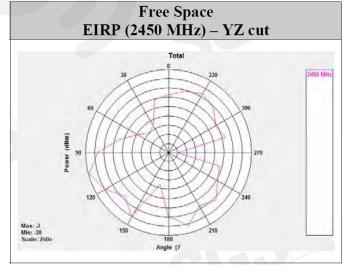
7.1. MDBT42Q series

Test Result

Frequency (MHz)	2400	2410	2420	2430	2440	2450	2460	2470	2480	2490	2500
Gain (dBi)	-3.68	-2.91	-2.34	-1.98	-1.66	-1.60	-1.77	-2.09	-2.60	-3.35	-4.10
Peak EIRP (dBm)	-3.68	-2.91	-2.34	-1.98	-1.66	-1.60	-1.77	-2.09	-2.60	-3.35	-4.10
Directivity (dBi)	4.98	5.11	5.12	5.02	4.93	4.76	4.58	4.38	4.11	3.77	3.42



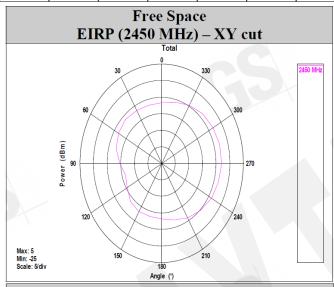


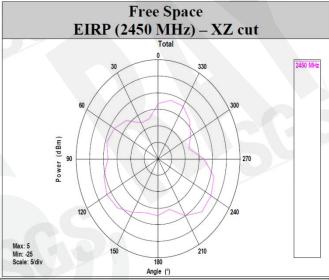


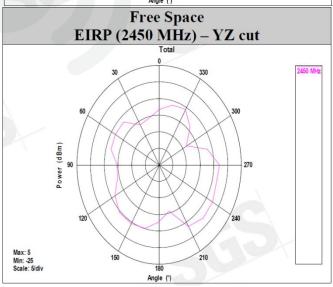
7.2. MDBT42Q-P series

Test Result

Frequency (MHz)	2400	2410	2420	2430	2440	2450	2460	2470	2480	2490	2500
Gain (dBi)	-3.87	-3.06	-2.31	-2.01	-2.04	-2.31	-2.24	-1.96	-1.61	-1.71	-1.97
Peak EIRP (dBm)	-3.87	-3.06	-2.31	-2.01	-2.04	-2.31	-2.24	-1.96	-1.61	-1.71	-1.97
Directivity (dBi)	3.79	4.00	4.25	4.17	3.86	3.51	3.54	3.91	4.39	4.44	4.49





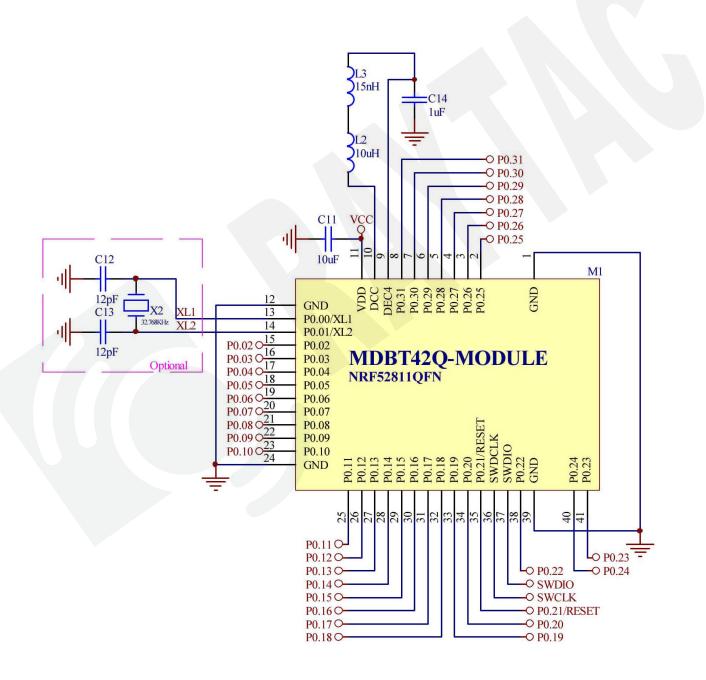


8. Reference circuit

Module is pre-programmed with Raytac's testing code. Default is using "LDO mode". Our firmware is set to use external 32.768KHz so please add it to make module work.

REMARK:

- ** When using DC-DC mode, please add L2 / L3 / C14. **
- ** When using internal 32.768KHz RC oscillator, please remove X2 / C12 / C13. **



9. Certification

9.1. Declaration ID for Bluetooth

<u>BT 5.4</u>

Declaration ID	\$ QDID(s)	\$ Company	\$	Specification Name	\$
D066910	232392 - End Product > 228005 - Component (Tested)	Raytac Corporation		5.4	

<u>BT 5.1</u>

Declaration ID	\$	QDID(s)	\$	Company	\$	Specification Name	\$
D047708		139361 - End Product		Raytac Corporation		5.1	

BT 5.2

Declaration ID	\$	QDID(s)	\$	Company	\$	Specification Name	\$
D053149		159932 - End Product		Raytac Corporation		5.2	

Profile Description	Service Description				
Alert Notification Profile	Alert Notification Service				
Dland Drangura Drafila	Blood Pressure Service				
Blood Pressure Profile	Device Information Service				
Cycling Speed & Codence Profile	Cycling Speed & Cadence Service				
Cycling Speed & Cadence Profile	Device Information Service				
Glucose Profile	Glucose Service				
Glucose Profile	Device Information Service				
Lloolth Thomas and the Drofile	Health Thermometer Service				
Health Thermometer Profile	Device Information Service				
Lloort Data Drafila	Heart Rate Service				
Heart Rate Profile	Device Information Service				
LUD aver CATT Drafile	HID Service				
HID over GATT Profile	Battery Service				
	Link Loss Service				
Proximity Profile	Immediate Alert Service				
	TX Power Service				
Dunning Chand & Cadanas Dusfile	Running Speed & Cadence Service				
Running Speed & Cadence Profile	Device Information Service				
Time Profile	Time Profile Service				
Glucose Profile (Central)					
Maala Duafila	Mesh Provisioning Service				
Mesh Profile	Mesh Proxy Service				

9.2. FCC certificate (USA)

BLE 1 Mbps



TCB

GRANT OF EQUIPMENT AUTHORIZATION

TCB

Certification Issued Under the Authority of the Federal Communications Commission

Telefication B.V. Edisonstraat 12a Zevenaar, NL-6902 PK Netherlands

Date of Grant: 01/02/2018

Application Dated: 12/18/2017

Raytac Corp. 5F., No.3, Jiankang Rd., Zhonghe Dist., New Taipei City,, 23586

Attention: Venson Liao, R&D Manager

NOT TRANSFERABLE

EQUIPMENT AUTHORIZATION is hereby issued to the named GRANTEE, and is VALID ONLY for the equipment identified hereon for use under the Commission's Rules and Regulations listed below.

FCC IDENTIFIER: Name of Grantee: **Equipment Class:**

SH6MDBT42Q Raytac Corp.

Digital Transmission System

Modular Type:

BLE Module

Single Modular

Grant Notes FCC Rule Parts

Frequency Range (MHZ) Output Frequency Emission Tolerance Designator Watts

15C 2402.0 - 2480.0 0.0023

C2PC: add BT5.0 by Firmware and change product name to BLE module from BT 4.2 module. To change module

to be certified under portable device.

Power output listed is conducted. This grant is valid only when the module is sold to OEM integrators and must be installed by the OEM or OEM integrators. The antenna's as listed in this application must not be co-located or installed by the OEM or OEM integrators are transmitter. Endusers may not be provided with the module operating in conjunction with any other antenna or transmitter. End-users may not be provided with the module installation instructions. OEM integrators and end-users must be provided with transmitter operating conditions for satisfying RF exposure compliance.

Certificate No .: 162181172/AA/02

George Lo Product Assessor George Lo

BLE 2 Mbps



TCB

GRANT OF EQUIPMENT AUTHORIZATION

Certification Issued Under the Authority of the Federal Communications Commission

By:

Telefication B.V. Edisonstraat 12a Zevenaar, NL-6902 PK Netherlands

Date of Grant: 01/02/2018

Application Dated: 12/18/2017

Raytac Corp. 5F., No.3, Jiankang Rd., Zhonghe Dist., New Taipei City,, 23586 Taiwan

Attention: Venson Liao , R&D Manager

NOT TRANSFERABLE

EQUIPMENT AUTHORIZATION is hereby issued to the named GRANTEE, and is VALID ONLY for the equipment identified hereon for use under the Commission's Rules and Regulations listed below.

FCC IDENTIFIER: SH6MDBT42Q Name of Grantee: Raytac Corp.

Digital Transmission System BLE Module Equipment Class:

Modular Type: Single Modular

Frequency Emission Tolerance Designator Output Frequency FCC Rule Parts Grant Notes Range (MHZ) Watts

2402.0 - 2480.0 0.0023 15C

C2PC: add BT5.0 by Firmware and change product name to BLE module from BT 4.2 module. To change module to be certified under portable device.

Power output listed is conducted. This grant is valid only when the module is sold to OEM integrators and must be installed by the OEM or OEM integrators. The antenna's as listed in this application must not be co-located or operating in conjunction with any other antenna or transmitter. End-users may not be provided with the module installation instructions. OEM integrators and end-users must be provided with transmitter operating conditions for satisfying RF exposure compliance.

Certificate No: 162181172/AA/02

George Lo Product Assessor George Lo

9.3. TELEC certificate (Japan)

BLE 1 Mbps

telefication by The Netherlands Chamber of Commerce 51565536 www.telefication.com



Certificate

Radio Equipment in JAPAN

No: 201-160496 / 00

Telefication, operating as Conformity Assessment Body (CAB ID Number: 201) with respect to Japan, declares that the listed product complies with the Technical Regulations Conformity Certification of Terminal equipment (ordinance of MPT N° 31,1984)

Product description: BT 4.2 Module Trademark: Raytac Type designation: MDBT42Q Hardware / Software version: 1/1 Variants: See Annex 3

> Manufacturer: Raytac Corporation Address: 5F, No.3, Jiankang Rd., Zhonghe Dist., City: New Taipei 23586

Country: Taiwan

This statement is granted to:

Name: Raytac Corporation Address: 5F, No.3, Jiankang Rd., Zhonghe Dist., City: New Taipei 23586 Country: Taiwan

This statement has THREE Annexes.

Zevenaar, 19 August 2016

CAB

Ramy Nabod Product Assessor



BLE 2 Mbps

telefication bv The Netherlands Chamber of Commerce 51565536 www.telefication.com



Certificate

of

Radio Equipment in JAPAN

No: 201-160496 / 02

Telefication, operating as Conformity Assessment Body (CAB ID Number: 201) with respect to Japan, declares that the listed product complies with the Technical Regulations Conformity Certification of Specified Radio equipment (ordinance of MPT N° 37,1981)

Product description: BLE Module
Trademark: Raytac
Type designation: MDBT42Q
Hardware / Software version: 1 / 1
Variants: See Annex 3

Manufacturer: Raytac Corporation
Address: 5F, No. 3, Jiankang Rd., Zhonghe Dist.
City: 23586 New Taipei City

Country: Taiwan

This certificate is granted to:

Name: Raytac Corporation
Address: 5F, No. 3, Jiankang Rd., Zhonghe Dist.

City: 23586 New Taipei City

Country: Taiwan

This certificate has THREE Annexes.

Zevenaar, 23 May 2019

CAB

David Chen

David Chen Product Assessor



9.4. NCC certificate (Taiwan)

MDBT42Q Series

BLE 1 Mbps & 2 Mbps

國家通訊傳播委員會電信管制射頻器材型式認證證明

一、申 請 者:勁遠國際電子有限公司

二、地 址:臺北市大安區和平東路1段145號5樓之1

三、製造廠商: 勁達國際電子有限公司

四、 器 材 名 稱: BLE Module

五、廠 牌:Raytac

六、型 號: MDBT42Q

七、發射功率(電場強度):詳細射頻規格如備註欄

八、工作頻率:詳細射頻規格如備註欄

九、審 验 日 期: 105年08月19日(換證日期: 108年06月19日)

十、審驗合格標籤式樣:

((CCAM16LP1180T2

國家通訊 胡貝爾泰美信數

十一、警語或標示要求:(器材本體、使用手冊、外包裝盒等應遵守下列標示要求)

- 應依審驗合格標籤或符合性聲明標籤式樣自製標籤黏貼或印鑄於電信管制射頻器材本體明顯 處,並於包裝盒標示本會標章, 始得關陳列或販賣。
- 2. 電信管制射頻器材應依本會或相關技術規範規定於指定位置標示中文警語。
- 經授權使用射頻模組(組件)之審驗合格樣嚴者,應於最終產品說明書及包裝盒提供充分與正確之資訊。
- 於網際網路販賣取得審驗證明之電信管制射頻器材者,應於該網際網路網頁提供審驗合格標 籤或符合性聲明標籤資訊。
- 5. 使用手册應標示下列資訊:

(1)經型式認證合格之低功率射頻電機,非經許可。公司、商號或使用者均不得擅自變更頻率、 加大功率或變更原設計之特性及功能。低功率射頻電機之使用不得影響機航安全及干擾合法 通信;經發現有干擾現氣時,應立即停用,並改善至無干擾時方得繼續使用。前項合法通信, 指依電信法規定作業之無線電通信。低功率射頻電機須忍受合法通信或工業、科學及醫療用 電液輻射性電機設備之干擾。

6. 本器材之審驗範圍僅限無線射頻硬體功能,不及於器材之資通安全檢測。

型式認證號碼: CCAM16LP1180T2

第 1 頁:井 2 頁

本證書與續頁分間使用無效

MDBT42Q-P Series

BLE 1 Mbps & 2 Mbps

國家通訊傳播委員會

電信管制射頻器材型式認證證明

一、申 請 者:勁達國際電子有限公司

二、地 址:臺北市大安區和平東路1段145號5樓之1

三、製造廠商:勁達國際電子有限公司

四、器材名稿: BLE Module

牌: Raytac 五、廠

六、型 號: MDBT42Q-P

七、發射功率(電場強度);詳細射頻規格如備註欄

八、工作頻率:詳細射頻規格如備註欄

九、審驗日期: 105年08月19日(換證日期: 108年06月19日)

十、審驗含格標籤式樣: (CCAM16LP1181T1



十一、警語或標示要求:(器材本體、使用手冊、外包裝盒等應遵守下列標示要求)

- 1. 應依審驗合格標籤或符合性聲明標籤式樣自製標籤黏贴或印鑄於電信管制射頻器材本體明顯 處,並於包裝盒標示本會標章,始得開陳列或販賣。
- 2. 電信管制射頻器材應依本會或相關技術規範規定於指定位置標示中文警語。
- 3. 經授權使用射頻模組(組件)之審驗合格標籤者,應於最終產品說明書及包裝盒提供充分與正
- 於網際網路販賣取得審驗證明之電信管制射頻器材者,應於該網際網路網頁提供審驗合格標 截或符合性聲明標籤資訊。
- 5. 使用手册應標示下列資訊:
 - (1)經型式認證合格之低功率射頻電機,非經許可,公司、商號或使用者均不得擅自變更頻率、 加大功率或變更原設計之特性及功能。低功率射頻電機之使用不得影響飛航安全及干擾合法 通信;經發現有干擾現象時,應立即停用,並改善至無干擾時方得繼續使用。前項合法通信, 指依電信法規定作業之無線電通信。低功率射頻電機須忍受合法通信或工業、科學及醫療用 電波輻射性電機設備之干擾。
- 6. 本器材之審驗範圍僅限無線射頻硬體功能,不及於器材之資通安全檢測。

型式認證號碼:CCAM16LP1180T2

第 1 頁,共 2 頁

本證書與續頁分開使用無效

9.5. CE test report (EU)

BLE 1 Mbps & 2 Mbps



SGS Reference No: MH/2019/40103C

VERIFICATION OF EMC COMPLIANCE

: MH/2019/40103C Verification No.

Representative Model No. MDBT42Q

Added Model(s) MDBT42Q-P, MDBT42Q-U

Product Name : BLE Module Brand Name : Raytac

Applicant : Raytac Corporation

: 5F, No.3, Jiankang Rd., Zhonghe Dist., New Taipei City, 23586, Taiwan Address of Applicant

Test Report Number : MH/2019/40103 : May 13, 2019 Date of Issue

Applicable Standards : EN 301 489 -1 v2.20: 2017-03 (Draft)

> EN 301 489 -17 v3.2.0: 2017-03 (Draft) EN 55032: 2015+AC:2016-07

EN 61000-4-2: 2009, EN 61000-4-3: 2006+A1:2008+A2:2010

Conclusion

The apparatus meets the requirements of the above standards and hence compliance the essential requirements under article 3.1b of the RED (2014/53/EU) Directive.

*This verification is only valid for the equipment and configuration described, and in conjunction with the test report as detailed above.

Authorized Signatory:

SGS TAIWAN LTD.

Eddy Cheng Technical Asst. Supervisor



Report No.: ER/2016/70008-05

Page: 1 of 53



RED (2014/53/EU) ETSI EN 300 328 v2.2.2 : 2019 TEST REPORT

FOR

Applicant: Raytac Corporation

5F, No.3, Jiankang Rd., Zhonghe Dist., New Taipei City,

23586, Taiwan

Product Name: BLE Module

Brand Name: Raytac

Model No.: MDBT42Q, MDBT42Q-P

Model Difference: MDBT42Q with Chip antenna,

MDBT42Q-P with PCB antenna

Report Number: ER/2016/70008-05

Issue Date: May 15, 2020

Date of Test: Jul. 04, 2016 ~ Nov. 28, 2017 (Original)

Apr. 16, 2020 ~May 04, 2020 (Updated)

Date of EUT Received: Jul. 04, 2016 (Original)

Apr. 16, 2020(Updated)

We hereby certify that:

The above equipment was tested by SGS Taiwan Ltd., Electronics & Communication Laboratory for compliance with the requirements set forth in the European Standard ETSI EN 300 328 v2.22: 2019 under RED 2014/53/EU. The results of testing in this report apply to the product system that was tested only. Other similar equipment will not necessarily produce the same results due to production tolerance and measurement uncertainties.

Approved By:

CHUN-CHIZEH, CFIFN

Chun Chieh Chen / Supervisor





9.6. IC certificate (Canada)

BLE 1 Mbps

The Netherlands Chamber of Commerce telefication

51565536 www.telefication.com

TECHNICAL ACCEPTANCE CERTIFICATE

CERTIFICAT D'ACCEPTABILITÉ TECHNIQUE

CERTIFICATION No.

8017A-MDBT42Q No. DE CERTIFICATION

TELEFICATION No. No. DE TELEFICATION

162170280/AA/01

TEST SITE No.

No. DE LABORATOIRE

4620A-5

ISSUED TO

Raytac Corporation

DÉLIVRÉ A

TYPE OF EQUIPMENT GENRE DE MATÉRIEL

Bluetooth device

TRADE NAME AND MODEL

Raytac / MDBT42Q

MARQUE ET MODELE

Raytac / MDBT42Q-P

CERTIFIED TO

SPECIFICATION

CERTIFIÉ SELON LE

CAHIER DES CHARGES

ISSUE

Certification of equipment means only that the equipment has met the requirements of the above-noted specification. Licence applications, where applicable to use certified equipment, are acted on accordingly by the Industry Canada issuing office and will depend on the existing radio environment, service and location of operation. This certificate is

radio environment, service and location of operation. This certificate is issued on condition that the holder complies and will continue to comply with the requirements and procedures issued by Industry Canada. The equipment for which this certificate is issued shall not be manufactured, imported, distributed, leased, offered for sale or sold unless the equipment complies with the applicable technical specifications and procedures issued by Industry Canada.

RSS-102 RSS-247

ISSUED BY TELEFICATION BY, RECOGNIZED CERTIFICATION BODY BY INDUSTRY CANADA DÉLIVRÉ PAR TELEFICATION BV, ORGANISME DE CERTIFICATION RECONNU PAR INDUSTRIE CANADA

I hereby attest that the subject equipment was tested and found in compliance with the above-noted specification. J'atteste, par la présente, que le matériel a fait <mark>l'objet d'</mark>essai et a été jugé conforme à la spécification ci-dessus

DATE 21 Feb 2017 BY

Mohammad Elhai Product Assessor

This certificate has one annex.



BLE 2 Mbps

telefication by The Netherlands

Chamber of Commerce 51565536





TECHNICAL ACCEPTANCE CERTIFICATE

CERTIFICAT D'ACCEPTABILITÉ **TECHNIQUE**

CERTIFICATION No.

8017A-MDBT42Q No. DE CERTIFICATION

TELEFICATION No. No. DE TELEFICATION

162170280/AA/02

TEST SITE No. No. DE LABORATOIRE

4620A-5

ISSUED TO DÉLIVRÉ A

Raytac Corporation

TYPE OF EQUIPMENT GENRE DE MATÉRIEL

Bluetooth device

Raytac / MDBT42Q

TRADE NAME AND MODEL MARQUE ET MODELE

Raytac / MDBT42Q-P

CERTIFIED TO CERTIFIÉ SELON LE

SPECIFICATION CAHIER DES CHARGES

RSS-102 RSS-247

Certification of equipment means only that the equipment has met the La certification du matériel signifie seulement que le matériel a satisfait equipment for which this certificate is issued shall not be manufactured, imported, distributed, leased, offered for sale or sold unless the equipment complies with the applicable technical specifications and procedures issued by ISED.

requirements of the above-noted specification. Licence applications, accordingly by the ISED issuing office and will depend on the existing radio environment, service and location of operation. This certificate is issued on condition that the holder complies and will continue to comply with the requirements and procedures issued by ISED. The consequence par le bureau de delivrance d'ISDE et dependent des conditions radio ambiantes, du service et de l'emplacement d'exploitation. Le présent certificat est délivré à la condition que le titulaire satisfasse et continue de satisfaire aux exigences et aux procédures d'ISDE. Le matériel à l'égard duquel le présent certificat est délivré ne doit pas être fabriqué, importé, distribué, loué, mis en vente ou vendu à moins d'être conforme aux procédures et aux spécifications techniques applicables publiées par ISDE.

ISSUED BY TELEFICATION BV (NL0001), RECO<mark>GNIZED C</mark>ERTIFICATION BODY BY INNOV<mark>ATION, SCIENCE AND ECONOMIC</mark>
DEVELOPMENT CANADA
DELIVIRE PAR TELEFICATION BV (NL0001), ORGANISME DE CERTIFICATION RECONNU PAR INNOVATION, SCIENCES ET
DEVELOPPEMENT ÉCONOMIQUE CANADA

I hereby attest that the subject equipment was tested and found in compliance with the above-noted specification. J'atteste, par la présente, que le matériel a fait l'objet d'essai et a été jugé conforme à la spécification ci-dessus

DATE 02 Jan 2018 BY

George Lo Product Assessor

This certificate has one annex.

George Lo



SRRC certificate (China) 9.7.

BLE 1 Mbps & 2 Mbps

编号: 2024-10173 Certificate No.

无线电发射设备型号核准证

Radio Transmission Equipment Type Approval Certificate 劲达国际电子股份有限公司(台湾):

根据《中华人民共和国无线电管理条例》,经审查,下列设备 准予颁发无线电发射设备型号核准证。

In accordance with the Radio Regulations of the People's Republic of China, after examination, the Radio Transmission Equipment Type Approval Certificate is granted to the following equipment.

设备名称: 蓝牙模块

Equipment Name

MDBT42Q 设备型号:

Equipment Type

2016DJ4571 核准代码:

CMIIT ID

数据传输 主要功能:

Main Functions

有效期:

2027-08-12

Validity

其他事项载于附页。

Additional Items as Seen in Attachments.

中华人民共和国工业和信息化部统一制作

Issued by the Ministry of Industry and Information Technology of the People's Republic of China

9.8. KC certificate (South Korea)

BLE 1 Mbps & 2 Mbps

358D-F9C0-417D-C63A	
	방송통신기자재등의 적합인증서 ficate of Broadcasting and Communication Equipments
상호 또는 성명 Trade Name or Applicant	Raytac Corporation
기자재명칭(명칭) Equipment Name	특정소출력 무선기기(무선데이터통신시스템용 무선기기)
기본모델명 Basic Model Number	MDBT42Q
파생모델명 Series Model Number	MDBT42Q-P, MDBT42Q-U
인증번호 Certification No.	MSIP-CRM-ryt-MDBT42Q
제조자/제조국가 Manufacturer/ Country of Origin	Raytac Corporation / 대만
인증연월일 Date of Certification	2016-10-06
기타 Others	

위 기자재는 「전파법」제58조의2 제2항에 따라 인증되었음을 증명합니다.

It is verified that foregoing equipment has been certificated under the Clause 2, Article 58-2 of Radio Waves Act.

2019년(Year) 12월(Month) 27일(Day)

국립전파연구원장



Director General of National Radio Research Agency

※ 인증 받은 방송통신기자재는 반드시**"적 합성평가표시"** 를 부착하여 유통하여야 합니다. 위반시 과태료 처분 및 인증이 취소될 수 있습니다.

9.9. RoHS & REACH report

Please visit "Support" page of our website to download.

9.10. End-Product label

It is suggested using following content adding to package or user manual or label to obey the regulation. Any rules of end-product label shall refer to each certification for final reference.

9.10.1. FCC (USA)

The FCC statement should be included in the user manual when there is no enough space on label. Otherwise, it should be included on the label.

"This device complies with part 15 of the FCC rules. Operation is subject to the following two conditions. (1) This device may not cause harmful interference. (2) This device must accept any interference received, including interference that may cause undesired operation."

The final end product must be labeled in a visible area with the following: "Contain FCC ID: SH6MDBT42Q".

9.10.2. TELEC (Japan)

When manufacturer is placing the product on the Japanese market, the product must be affixed with the following Specified Radio Equipment marking:



9.10.3. NCC (Taiwan)

請依下列標籤式樣自製標籤,標貼或印鑄於器材本體明顯處,始得販賣或公開陳列。



以 MDBT42Q 為例,平台廠商必須於平台上標示字樣「本產品內含射頻模組: ID 編號 CCAM16LP1180T2」。

「平台」定義如下:若器材組裝本案模組,消費者仍能正常使用該器材主要功能,該器材得視 為平台。若器材不組裝本案模組,消費者不能正常使用該器材主要功能,該器材不能視為平台。 該類不同廠牌型號器材組裝本案審驗模組後,須分別申請型式認證。

9.10.4. IC (Canada)

The IC statement should be included in the user manual when there is no enough space on label. Otherwise, it should be included on the label.

"This device complies with Industry Canada license-exempt RSS Standard(s). Operation is subject to the following two conditions. (1) This device may not cause harmful interference. (2) This device must accept any interference received, including interference that may cause undesired operation.

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence.L'exploitation est autorisée aux deux conditions suivantes: (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement."

The final end product must be labeled in a visible area with the following: "Contain IC ID: 8017A-MDBT42Q".

10. Notes and cautions

Module is not designed to last for a lifetime. Like general products, it is expected to be worn out after continuous usage through the years. To assure that product will perform better and last longer, please make sure you:

- Follow the guidelines of this document while designing circuit/end-product. Any
 discrepancy of core Bluetooth technology and technical specification of IC should refer to
 definition of Bluetooth Organization and Nordic Semiconductor as final reference.
- Do not supply voltage that is not within range of specification.
- Eliminate static electricity at any cost when working with the module as it may cause damage. It is highly recommended adding anti-ESD components to circuit design to prevent damage from real-life ESD events. Anti-ESD methods can be also applied in mechanical design.
- Do not expose modules under direct sunlight for long duration. Modules should be kept away from humid and salty air conditions, and any corrosive gasses or substances. Store it within -40°C to +125°C before and after installation.
- Avoid any physical shock, intense stress to the module or its surface.
- Do not wash the module. No-Clean Paste is used in production. Washing it will oxidize
 the metal shield and have chemistry reaction with No-Clean Paste. Functions of the
 module are not guaranteed if it has been washed.

The module is not suitable for life support device or system and not allowed to be used in destructive device or systems in any direct or indirect ways. The customer agrees to indemnify Raytac for any losses when applying modules in applications such as the ones described above.

11. Basic facts for nRF52 chip

Below chart shows basic spec for Nordic nRF52 family, which is helpful to understand the differences between each SoC. Any discrepancy shall refer to Nordic's technical document as final reference.

See *錯誤! 找不到參照來源。* for complete model no. of each item.

Nordic Solution	nRF52840	nRF52833	nRF52820	nRF52832	nRF52810	nRF52811	nRF52805
RAYTAC Model No. (MDBTXX)	50Q series	50Q series 50 series	50 series	42Q series 42 series 42V series	42Q series	42Q Series	42T series 42TV series
Bluetooth Direction Finding		٧	V			V	
Bluetooth 5 Long Range (125kbps)	V	٧	V			V	
Bluetooth 5 High Speed	V	v	V	v	V	v	V
Bluetooth 5 Ad. Extention (x8)	V	v	v	v	v	v	V
Flash (kBytes)	1024	512	256	512	192	192	192
RAM (kBytes)	256	128	32	64	24	24	24
ANT Plus	V	V	V	V	V	V	
IEEE 802.15.4	V	V	V			V	
ARM® TrustZone® Cryptocell	v						
USB	V	V	V				
QSPI	V						
NFC	V	V		V			
128	V	V		V			
SPI, TWI, UART, PWM	V	V	V	V	V	V	without PWM
PDM	V	V		V	V	V	
ADC, Comparators	V	V	without ADC	V	V	V	without comparators
Supply Range (V)	1.7 to 5.5	1.7 to 5.5	1.7 to 5.5	1.7 to 3.6	1.7 to 3.6	1.7 to 3.6	1.7 to 3.6

12. Useful links

- Nordic Infocenter: https://infocenter.nordicsemi.com/index.jsp
 All the necessary technical files and software development kits of Nordic's chip are on this website.
- Nordic DevZone: https://devzone.nordicsemi.com/questions/
 A highly recommended website for firmware developer. Interact with other developers and Nordic's employees will help with your questions. The site also includes tutorials in detail to help you get started.
- Official Page of nRF52811: https://www.nordicsemi.com/Products/Low-power-short-range-wireless/nRF52811
 https://www.nordicsemi.com/Products/Low-power-short-range-wireless/nRF52811
 https://www.nordicsemi.com/Products/Low-power-short-range-wireless/nRF52811
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 https://www.nordicsemi.com/
 https://www.nordicsemi.com/<

Full list of Raytac's Wi-Fi modules

AN7002Q series (QFN package IC)

Series	Nordic Solution	Raytac No.	IC Ver.	Antenna	Size	Weight
		AN7002Q	1	Chip Antenna	17.1 x 10.8 x 2.1 mm	0.78 (±0.02g)
AN7002Q	nRF7002	AN7002Q-P	1	PCB Antenna	17.1 x 10.8 x 2.1 mm	0.79 (±0.02g)
		AN7002Q-U	1	u.FL Connector	16.4 x 10.8 x 2.1 mm	0.85 (±0.02g)

Full list of Raytac's Bluetooth modules

AN54LQ series (QFN package IC)

Series	Nordic Solution	Raytac No.	IC Ver.	Antenna	RAM	NVM
	nRF54L15	AN54LQ-15	1		256 kB	1.5 MB
AN54LQ	nRF54L10	AN54LQ-10	1	Chip Antenna	192 kB	1MB
	nRF54L05	AN54LQ-05	1	_	96 kB	0.5MB
	nRF54L15	AN54LQ-P15	1	PCB Antenna	256 kB	1.5 MB
AN54LQ-P	nRF54L10	AN54LQ-P10	1		192 kB	1MB
	nRF54L05	AN54LQ-P05	1		96 kB	0.5MB
	nRF54L15	AN54LQ-U15	1	u.FL Connector	256 kB	1.5 MB
AN54LQ-U	nRF54L10	AN54LQ-U10	1		192 kB	1MB
	nRF54L05	AN54LQ-U05	1		96 kB	0.5MB

AN54LV series (WLCSP package IC)

Series	Nordic Solution	Raytac No.	IC Ver.	Antenna	RAM	NVM
AN54LV	mRF54L15	AN54LV-15	1	Chip Antenna	— 256 kB	1.5 MB
AN54LV-P		AN54LV-P15	1	PCB Antenna		

MDBT53 series (WLCSP package IC)

Series	Nordic Solution	Raytac No.	IC Ver.	Antenna	RAM	Flash Memory
MDBT53	nRF5340	MDBT53-1M	1	Chip Antenna	512 kB	1 MB
MDBT53-P	nRF5340	MDBT53-P1M	1	PCB Antenna	512 kB	1 MB
MDBT53-U	nRF5340	MDBT53-U1M	1	u.FL Connector	512 kB	1 MB

MDBT53V series (WLCSP package IC)

Series	Nordic Solution	Raytac No.	IC Ver.	Antenna	RAM	Flash Memory
MDBT53V	nRF5340	MDBT53V-1M	1	Chip Antenna	512 kB	1 MB
						_
MDBT53V-P	nRF5340	MDBT53V-P1M	1	PCB Antenna	512 kB	1 MB

MDBT50 series (QFN package IC)

Series	Nordic Solution	Raytac No.	IC Ver.	Antenna	RAM	Flash Memory
MDBT50	nRF52820	MDBT50-256R	1	_ Chip	32 kB	256 kB
	nRF52833	MDBT50-512K	1	Antenna	128 kB	512 kB
MDBT50-P	nRF52820	MDBT50-P256R	1	PCB	32 kB	256 kB
	nRF52833	MDBT50-P512K	1	Antenna	128 kB	512 kB

MDBT50Q series (aQFN package IC)

Series	Nordic Solution	Raytac No.	IC Ver.	Antenna	RAM	Flash Memory
	nRF52840	MDBT50Q-1MEN	3		25215	
MDBT50Q	nRF52840	MDBT50Q-1MV2	2	Chip Antenna	256 kB	1 MB
	nRF52833	MDBT50Q-512K	1		128 kB	512 kB
	nRF52840	MDBT50Q-P1MEN	3	_	050 kD	1 MB
MDBT50Q-P	nRF52840	MDBT50Q-P1MV2	2	PCB Antenna	256 kB	
	nRF52833	MDBT50Q-P512K	1		128 kB	512 kB
	nRF52840	MDBT50Q-U1MEN	3		050 LD	4 MD
MDBT50Q-U	nRF52840	MDBT50Q-U1MV2	2	u.FL Connector	256 kB	1 MB
	nRF52833	MDBT50Q-U512K	1		128 kB	512 kB
Dongle	nRF52840	MDBT50Q-RX	1, 2	PCB Antenna	256 kB	1 MB
	11KF3Z04U	MDBT50Q-CX-40	1		∠30 KB	I IVID
	nRF52833	MDBT50Q-CX-33	1		128 kB	512 kB

MDBT42T series (WLCSP package IC)

Series	Nordic Solution	Raytac No.	IC Ver.	Antenna	RAM	Flash Memory
MDBT42T	DE50005	MDBT42 <mark>T</mark> -192K	4	Chip Antenna	– 24 kB	192 kB
MDBT42T-P	─ nRF52805	MDBT42T-P192K	- 1	PCB Antenna		

MDBT42TV series (WLCSP package IC)

Series	Nordic Solution	Raytac No.	IC Ver.	Antenna	RAM	Flash Memory
MDBT42TV	DE 50005	MDBT42TV-192K		Chip Antenna	- 04 kD	400 kD
MDBT42TV-P	nRF52805	MDBT42TV-P192K		PCB Antenna	— 24 kB	192 kB

MDBT42 series (WLCSP package IC)

Series	Nordic Solution	Raytac No.	IC Ver.	Antenna	RAM	Flash Memory
MDBT42	— nRF52832	MDBT42-512KV2	2	Chip Antenna	— 64 kB	512 kB
MDBT42-P	IIKF32032	MDBT42-P512KV2	2	PCB Antenna	— 04 KD	312 KB

MDBT42V series (WLCSP package IC)

Series	Nordic Solution	Raytac No.	IC Ver.	Antenna	RAM	Flash Memory
MDBT42V	− nRF52832	MDBT42V-512KV2	2	Chip Antenna	C4 kD	512 kB
MDBT42V-P		MDBT42 <mark>V</mark> -P512KV2		PCB Antenna	─ 64 kB	

MDBT42Q series (QFN package IC)

Series	Nordic Solution	Raytac No.	IC Ver.	Antenna	RAM	Flash Memory
MDBT42Q	nRF52832	MDBT42 <mark>Q</mark> -512KEN	3	- _ Chip Antenna -	64 kB	512 kB
	nRF52832	MDBT42 <mark>Q</mark> -512KV2	2			
	nRF52810	MDBT42 <mark>Q</mark> -192KV2	2		24 kB	192 kB
	nRF52811	MDBT42Q-192KL	1			
MDBT42Q-P	nRF52832	MDBT42Q-P512KEN	3	PCB Antenna	64 kB	512 kB
	nRF52832	MDBT42Q-P512KV2	2			
	nRF52810	MDBT42Q-P192KV2	2		24 kB	192 kB
	nRF52811	MDBT42Q-P192KL	1			
MDBT42 <mark>Q</mark> -U	nRF52832	MDBT42Q-U512KEN	3	u.FL Connector	64 kB	512 kB
	nRF52832	MDBT42Q-U512KV2	2			

MDBT40 series

Series	Nordic Solution	Raytac No.	IC Ver.	Antenna	RAM	Flash Memory
MDBT40	nRF51822	MDBT40-256V3	2	Chip Antenna	16 kB	256 kB
		MDBT40-256RV3	- 3		32 kB	256 kB
MDBT40-P	nRF51822	MDBT40-P256V3	3	PCB Antenna	16 kB	256 kB
		MDBT40-P256RV3			32 kB	256 kB

Release note

- 2019/06/24 Version A: 1st release
- 2020/06/30 Version B
 - (1) Moved section 3 of Chapter 1 under section 1 of Chapter 9: Declaration ID
 - (2) Added tolerance information and updated layout of solder pad in Chapter 2: Product Dimension.
 - (3) Removed Tape & Reel information in Chapter 4: Shipment Packaging Information.
 - (4) Updated CE reports to EN300.328 V2.2.2 & EN62368-1 in Chapter 9: Certification.
 - (5) Added nRF52820 in Chapter 11: Basic Facts of nRF52 Family.
 - (6) Updated Full List of Raytac's BLE modules.
- 2020/12/31 Version C
 - (1) Updated information of T&R in Chapter 4: Shipment Packaging Information.
 - (2) Added BT 5.2 SIG approval in Chapter 9: Certification.
 - (3) Updated table in Chapter 11: Basic Facts for nRF52 Family
 - (4) Updated Full List of Raytac's BLE Modules.
- 2021/07/07 Version D
 - (1) Updated graphs in section 2 of Chapter 2: Product Dimension.
 - (2) Updated information of T&R in Chapter 4: Shipment Packaging Information.
 - (3) Refined description of test code in Chapter 8: Reference Circuit
 - (4) Updated SRRC Certificate in Chapter 9: Certification.
- 2022/07/01 Version E
 - (1) Updated Chapter 4: 4.2.1 Tray Packaging with 4.2.2 Tape & Reel Packaging info.
 - (2) Updated Chapter 2: 2.3 RF Layout Suggestion (aka Keep-Out Area).
 - (3) Updated List of Raytac's Model no.
 - (4) Updated Chapter 5: Specification corresponding to Nordic's new nRF52811 Product Specification V1.1.

- 2023/06/20 Version F
 - (1) Updated drawing in Chapter 2 for a better understanding of PCB measurement & RF Layout Suggestion.
- 2025/07/14 Version G
 - (1) Updated Chapter 5: Specification corresponding to Nordic's new nRF52811 Product Specification V1.2.
 - (2) Updated the SRRC (China) certificate in Chapter 9: Certification.
 - (3) Added declaration ID for BT5.4 in Chapter 9.1.
 - (4) Added the list of Raytac's Wi-Fi models.
 - (5) Updated the list of Raytac's model numbers.
 - (6) Updated the company logo and service email address information.